

Innovationen und Trends in der Leistungselektronik

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Outline

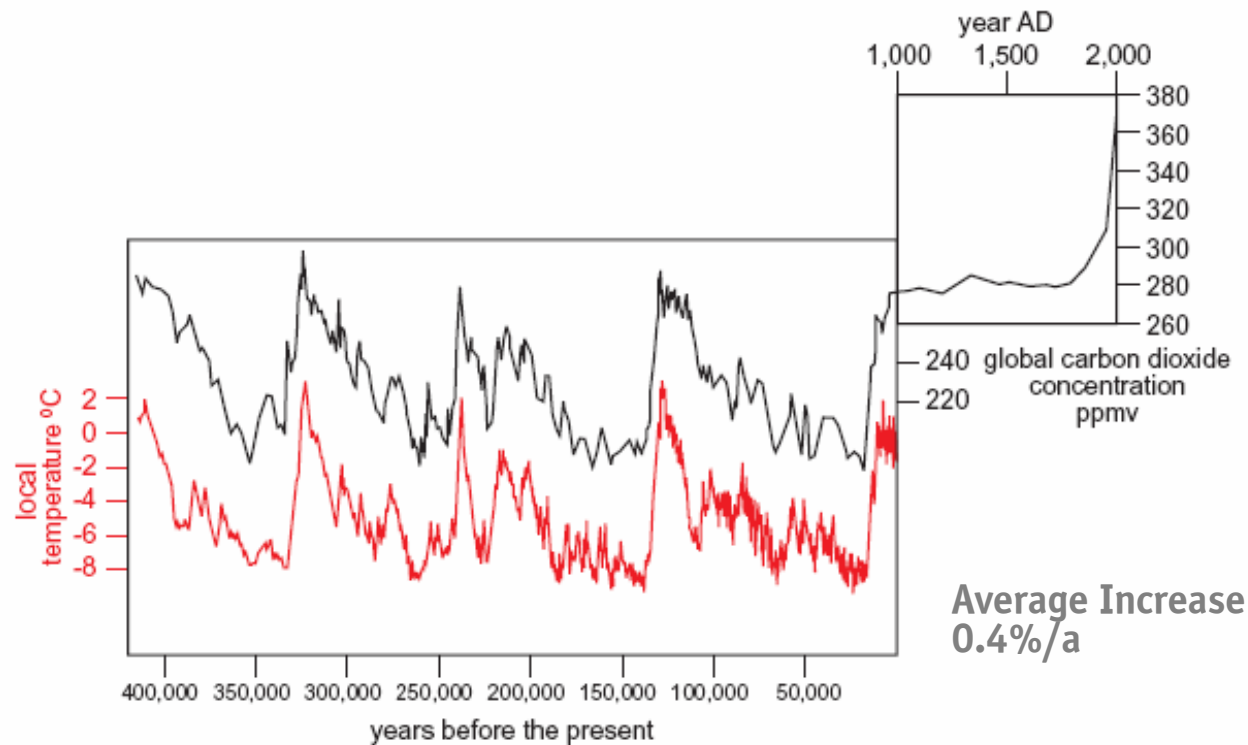
Power Electronics Applications

Voltage Regulator Module
IT Distributed Power Supply
Hybrid Vehicle
More Electric Aircraft
Drive Systems
Distributed Generation

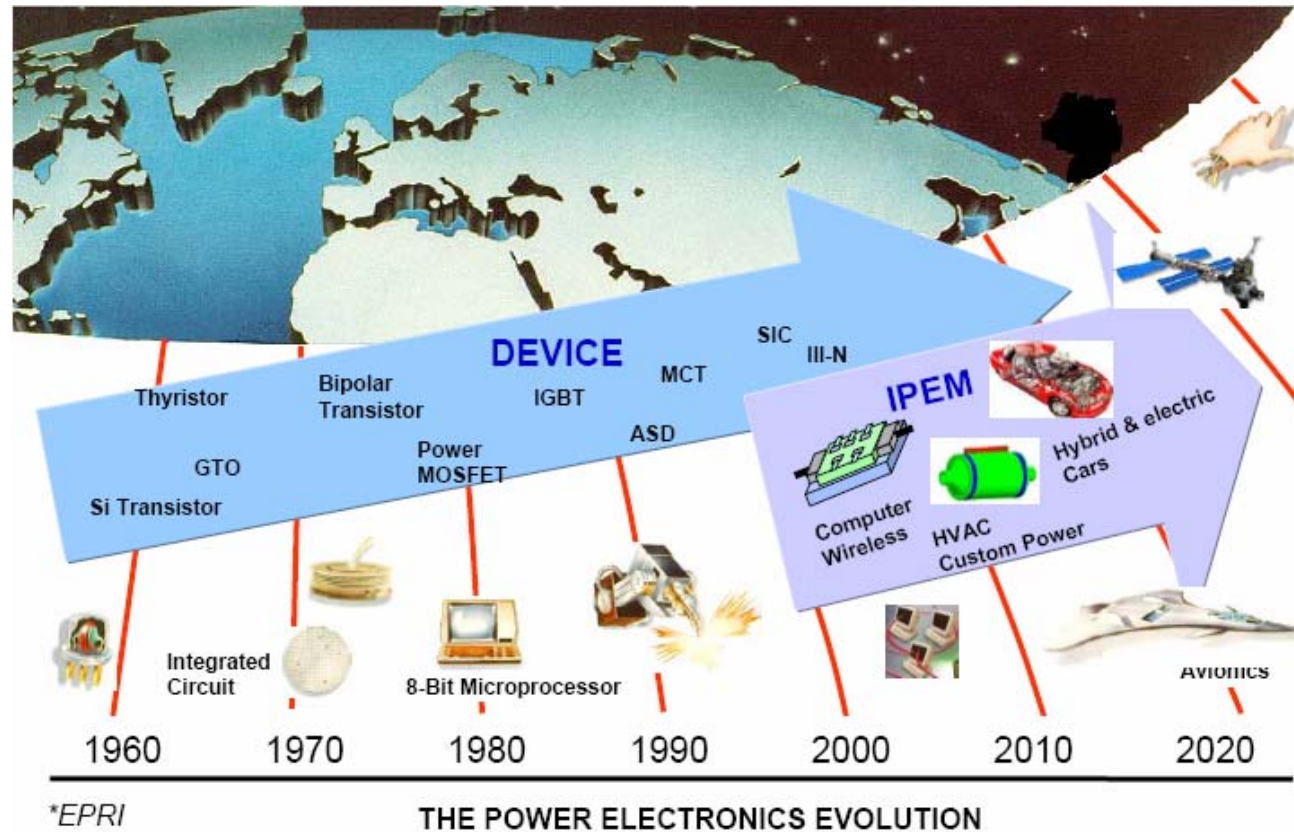
Power Semiconductor Development
Power Electronics Research Centers

Carbon Dioxide Concentration and Temperature

Evidence from Ice Cores



Power Electronics Evolution



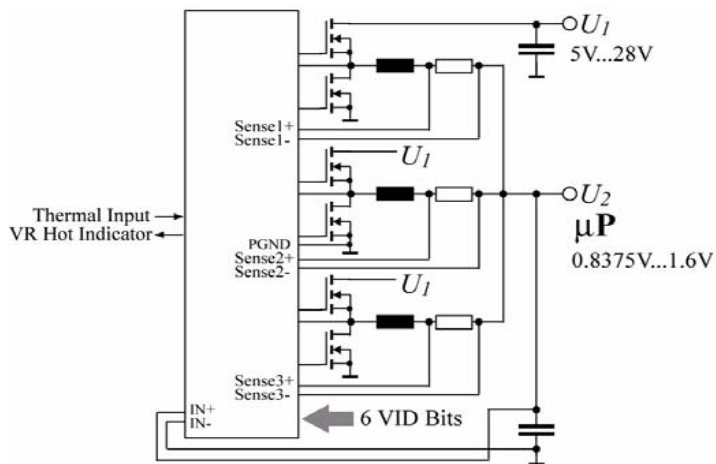
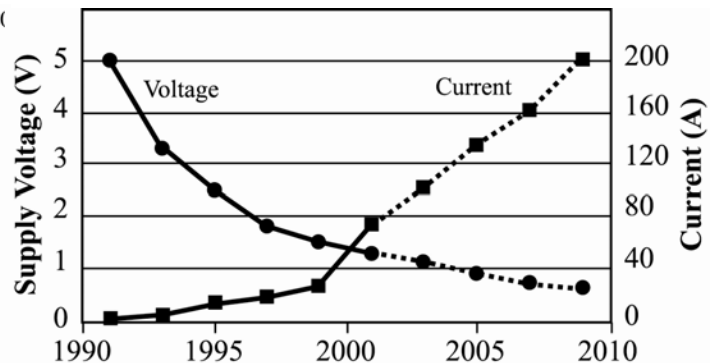
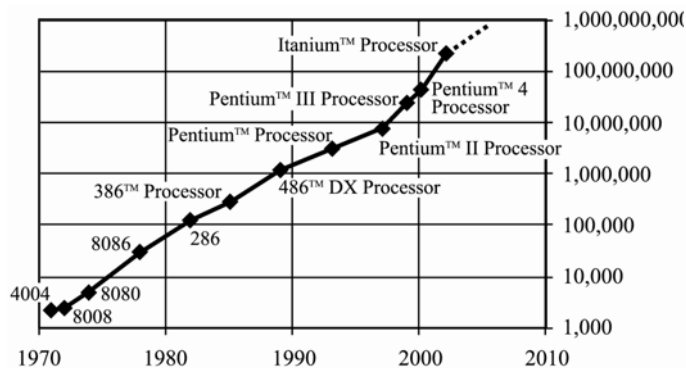
IT Distributed Power Supply

Server-Farm
450 MW/1.5kW/m²
99.9999%/<30s/a
\$1.0 Mio./shutdown



US 15% Digital
Economy Electricity
Consumption

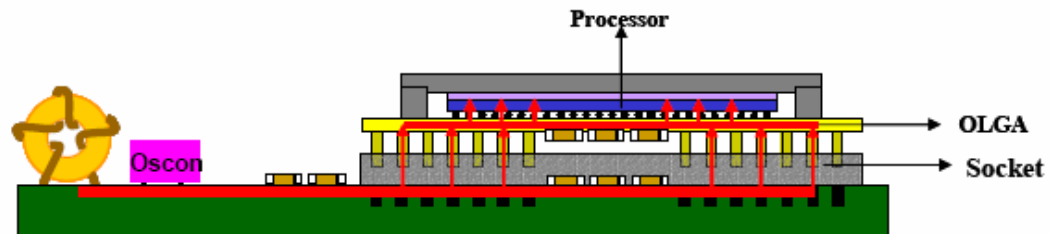
Voltage Regulator Module



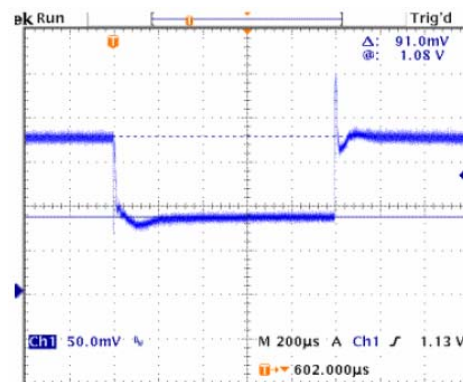
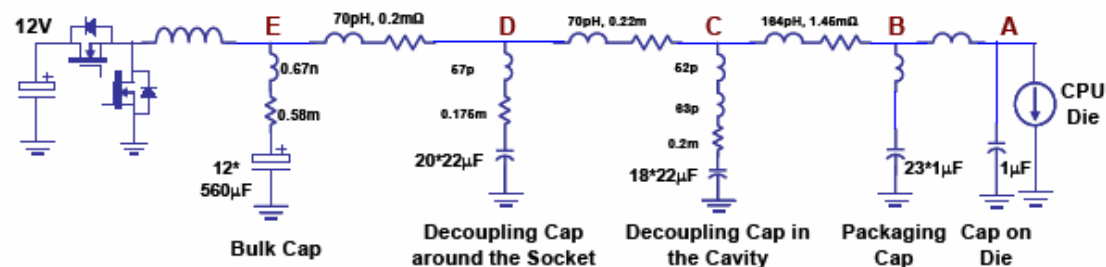
Moore's Law will Prevail for the Next Decade
 1 Billion Transistors
 15 GHz by 2010
 0.8V / 200A
 250A/ns @ 1% Supply Voltage Tolerance

Power and Thermal Limitations
 → Power Wall

Voltage Regulator Module



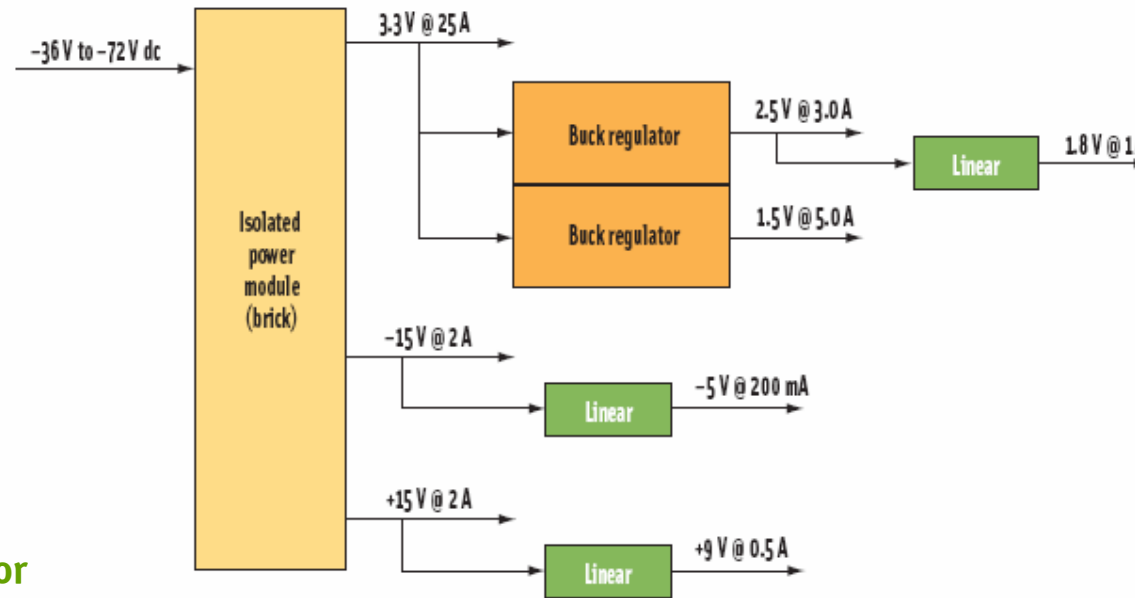
(a)



Dynamic Behavior

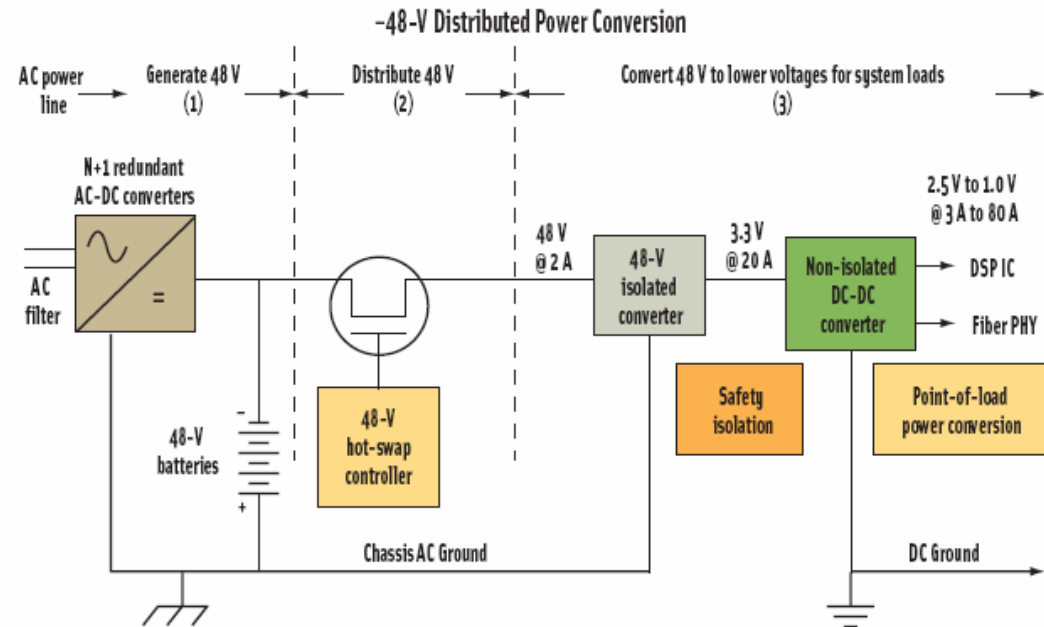
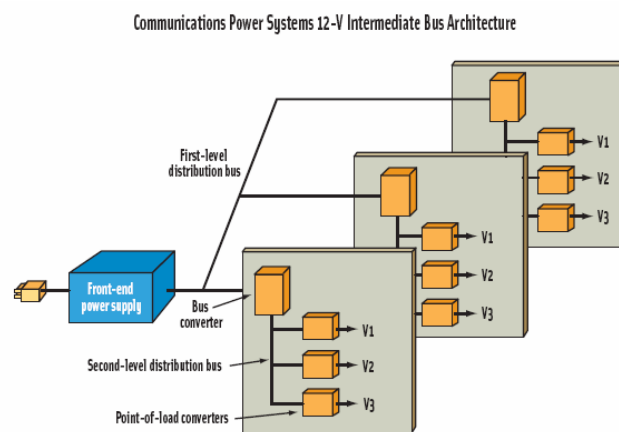
Traditional IT Power System Architecture

Traditional -48-V Communications Distributed Power Architecture



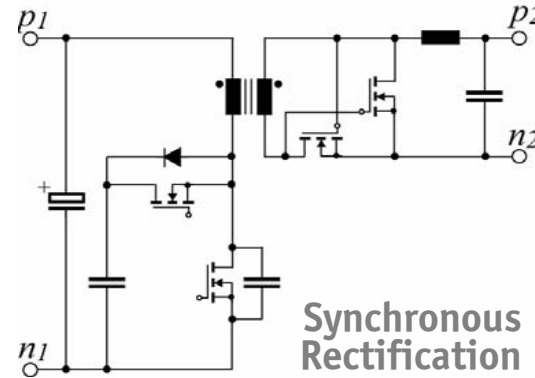
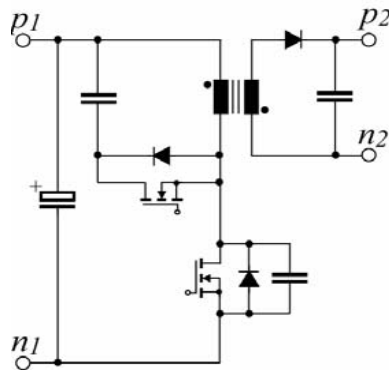
Linear Post Regulator

Intermediate Bus Architecture



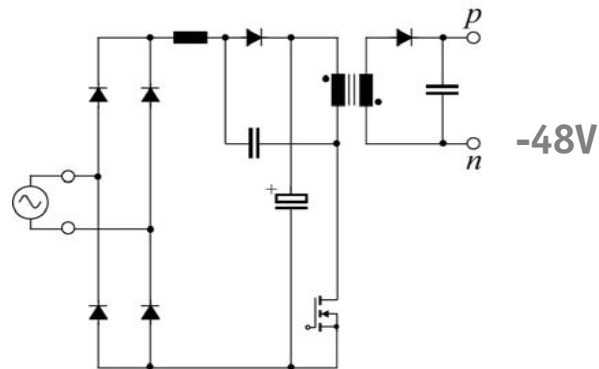
Intermediate Bus Architecture

**Active
Clamp
Flyback and
Forward
Converter**



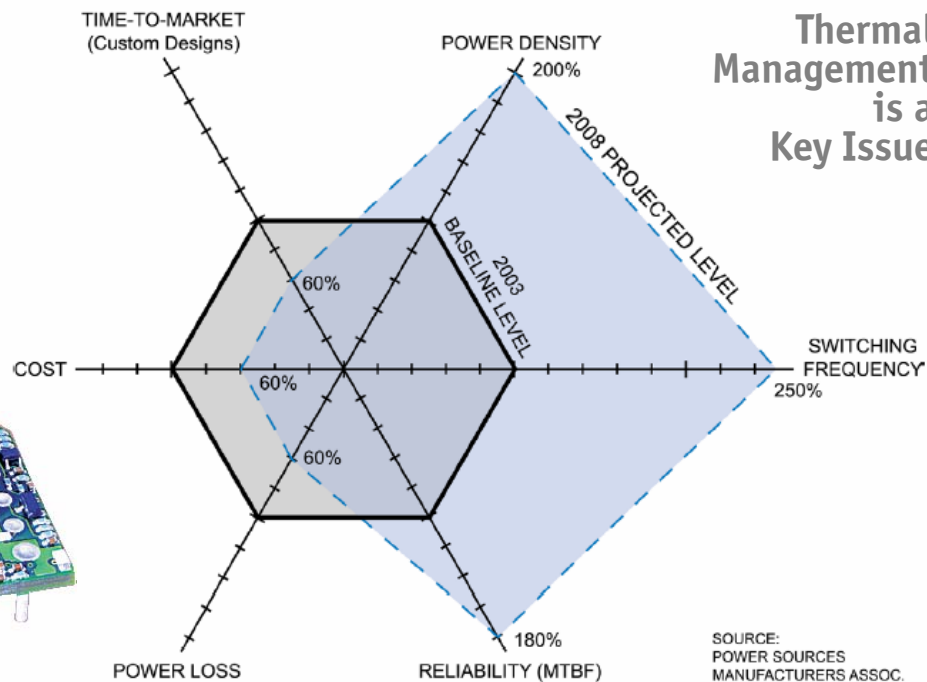
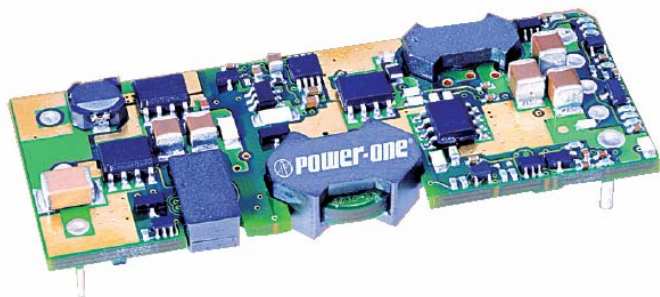
**Synchronous
Rectification**

**Single-Stage
Power
Factor
Correction**



DC/DC Converter Development Route

2003 - 2008

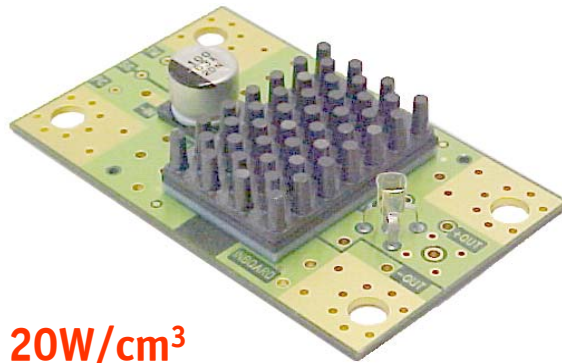


Thermal Management is a Key Issue

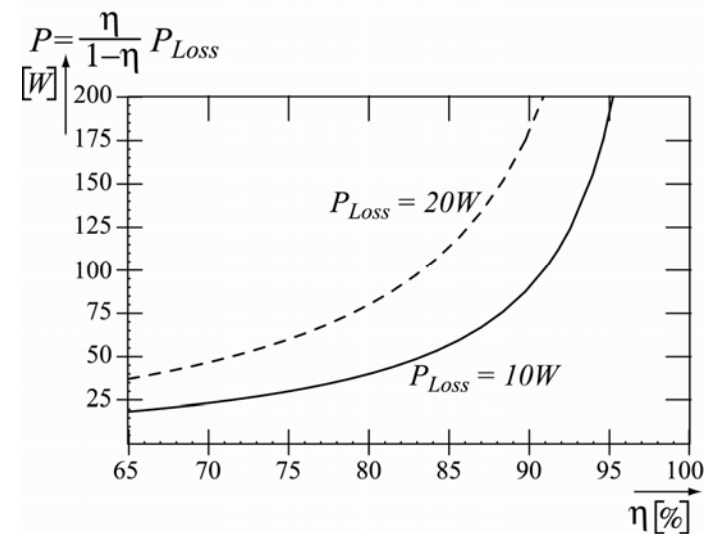
SOURCE: POWER SOURCES MANUFACTURERS ASSOC.

DC/DC Bus Converter Module

48V / 12V isolated
200W cont. Output
>96% Efficiency
3.5MHz (eff.)
BGA Surface Mounting

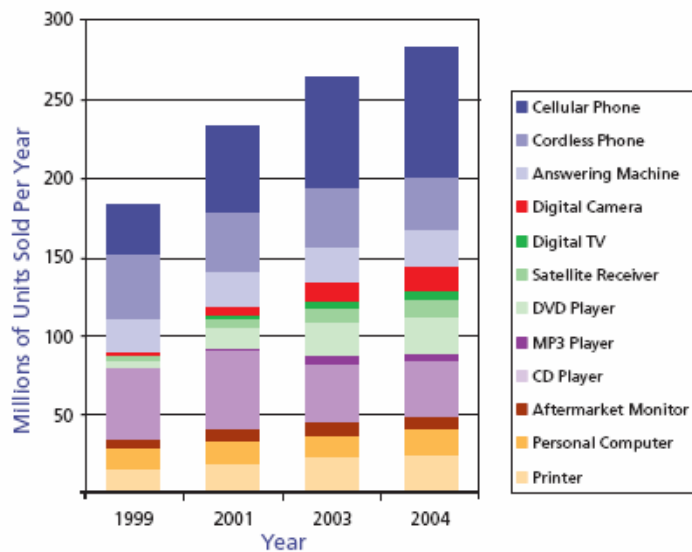


20W/cm³

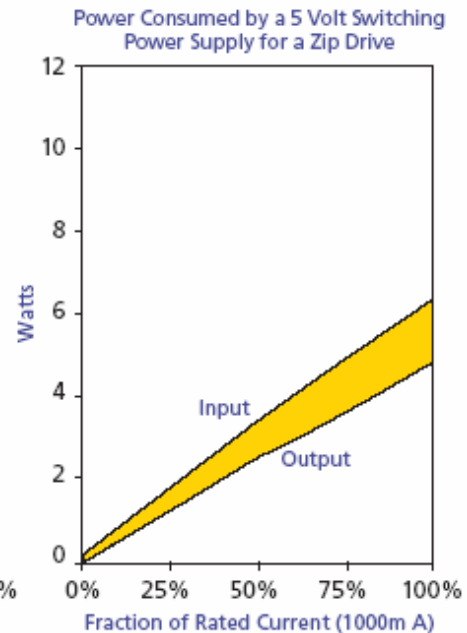
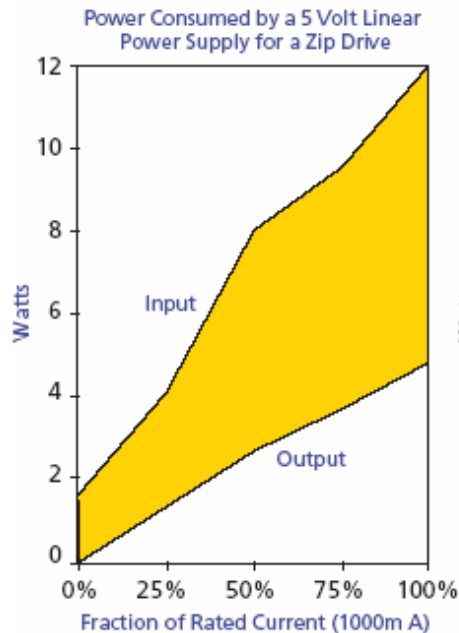


Power Supply Energy Efficiency

10 Billion Power Supplies in Use Worldwide
10% of US Electricity Use
30...60% Efficient

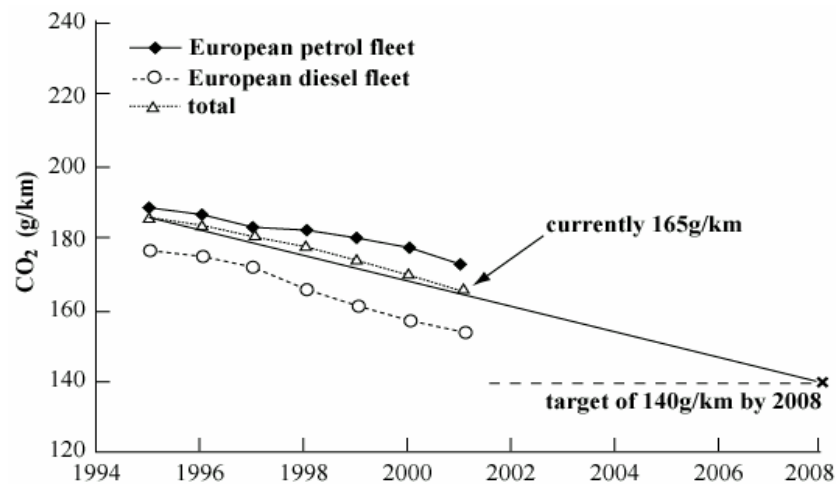
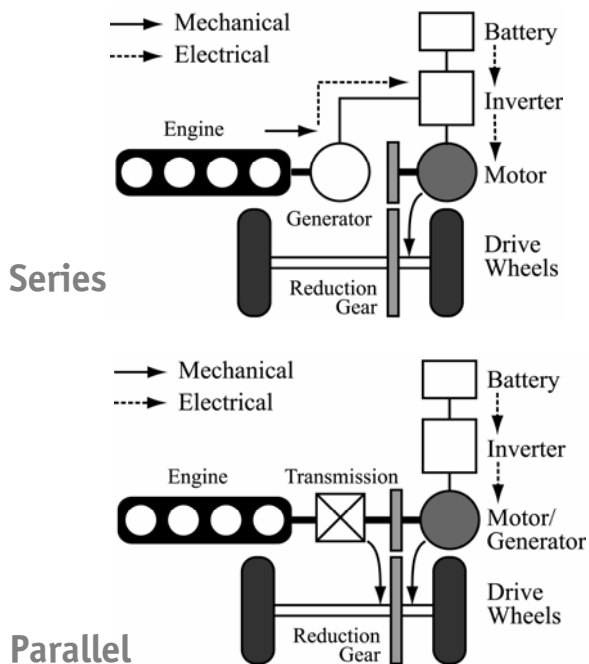


U.S. sales of these power supply-containing products are expected to rise 55% between 1999 and 2004. Source: Consumer Electronics Association



The shaded areas represent the net power consumption of each power supply – the amount of ac power input that is converted to heat instead of becoming useful dc power output. Both units are designed to produce a similar amount of dc output power across a range of loading conditions. But at 100% load, the linear design draws nearly twice the ac power of the switching design (12 watts vs. 6.3 watts). At 0% load, it draws more than 8 times the ac power (1.7 watts vs. 0.2 watts).

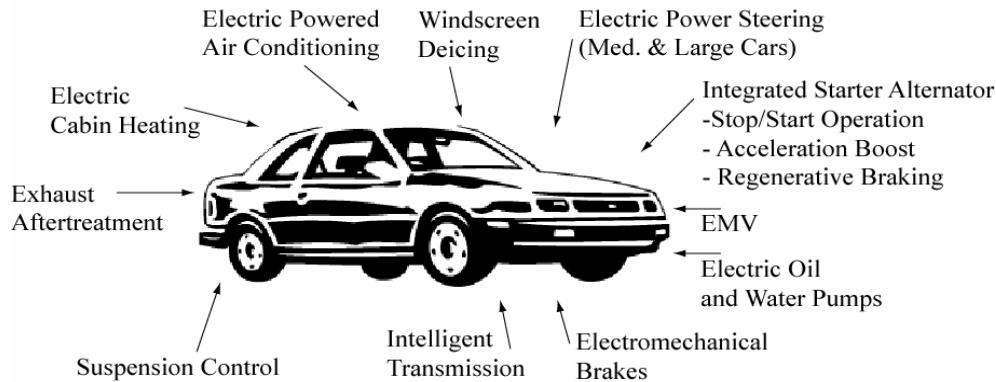
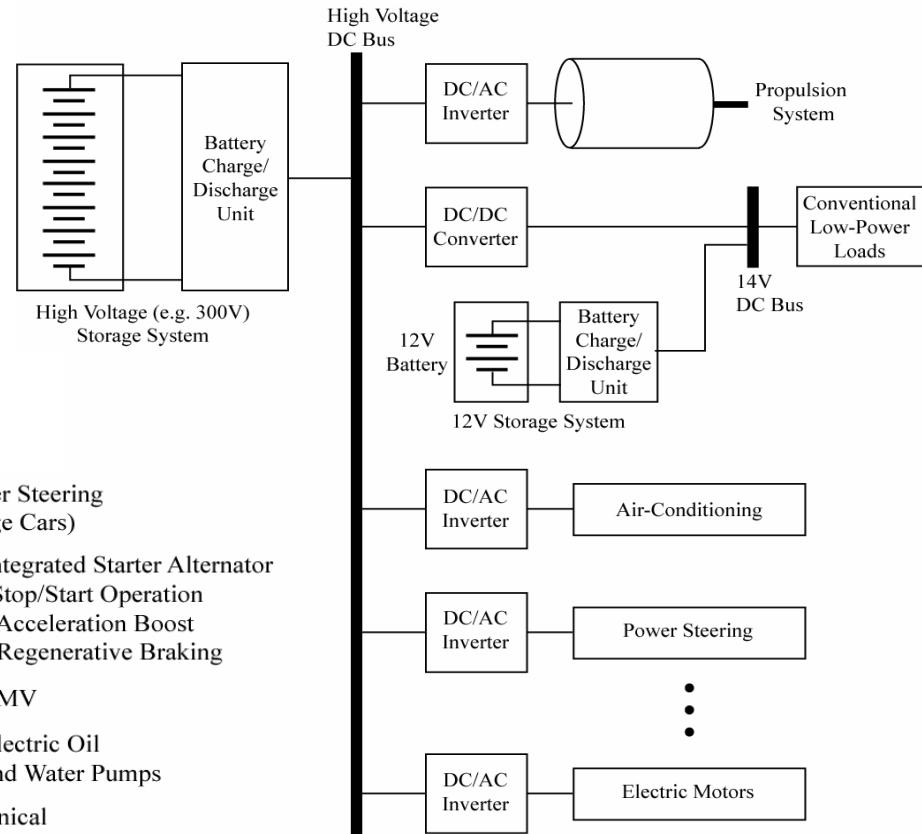
Hybrid Car



Hybrid Car

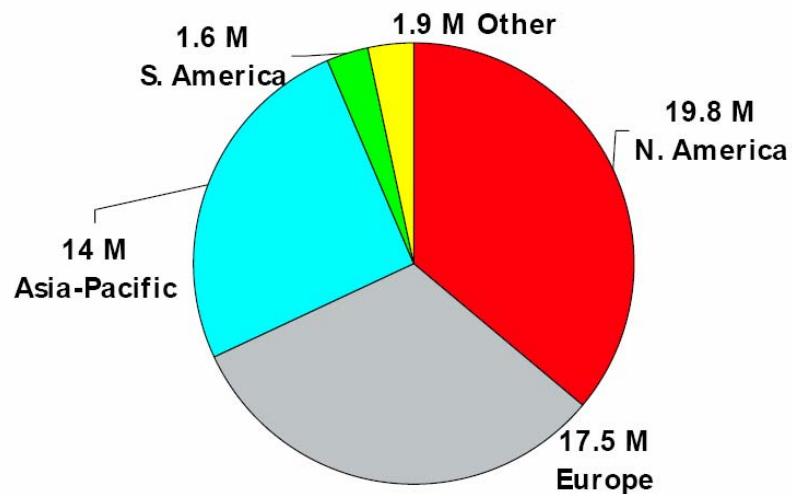
Power System Architecture

300...500V High Voltage DC Bus
14V Battery

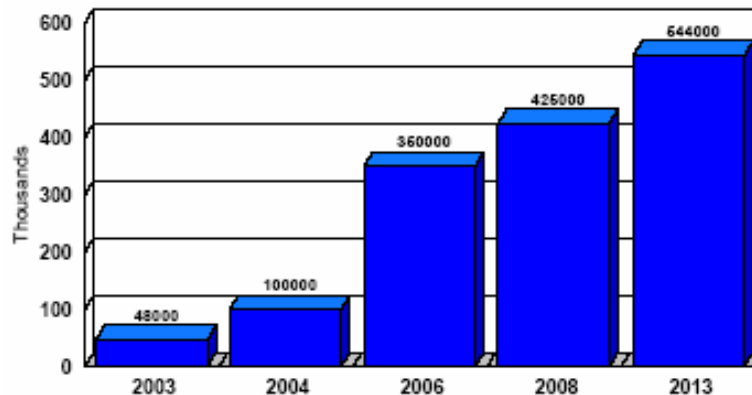


Hybrid Car Share Forecast

Annual World-Wide
Car Manufacturing



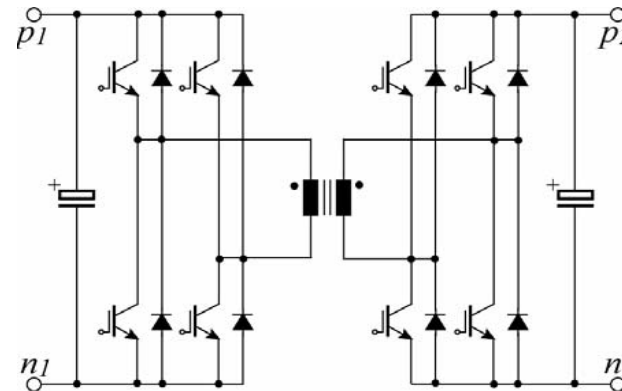
Forecast of
Hybrid Vehicle in US



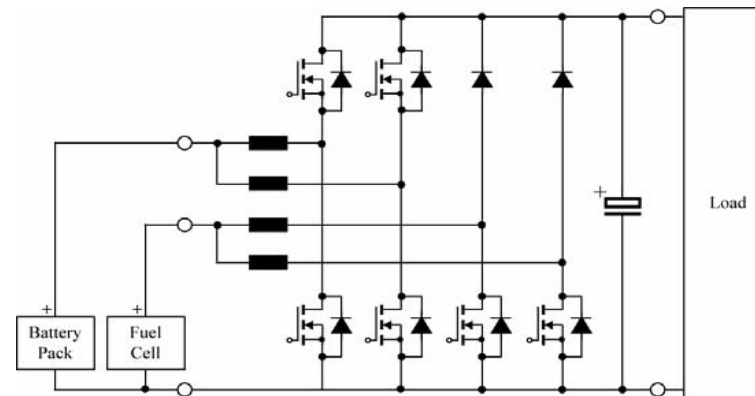
Hybrid Car

Bidirectional DC/DC Converter Topologies

Isolated

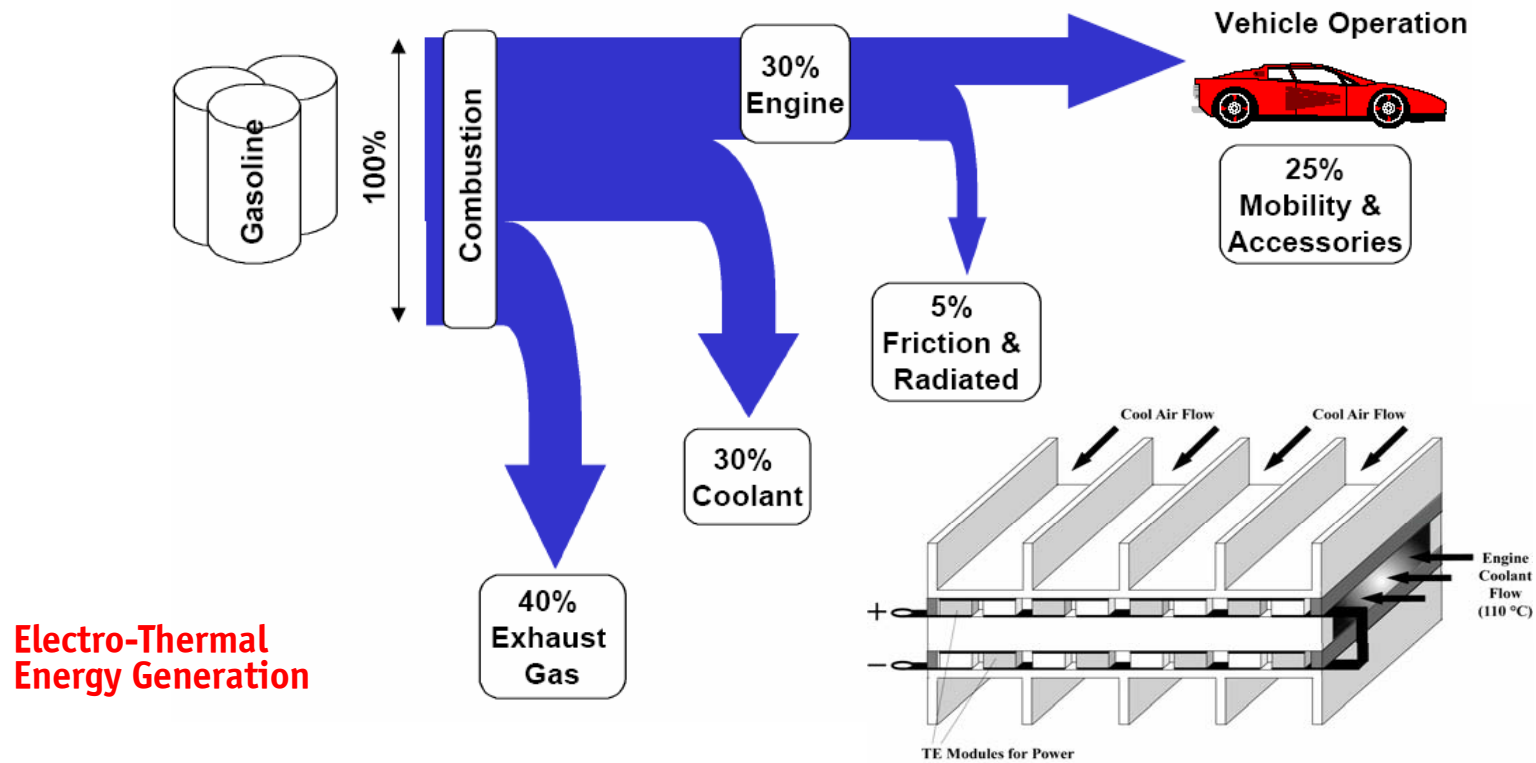


Non-Isolated
Bidirectional / Unidirectional



More Electric Car

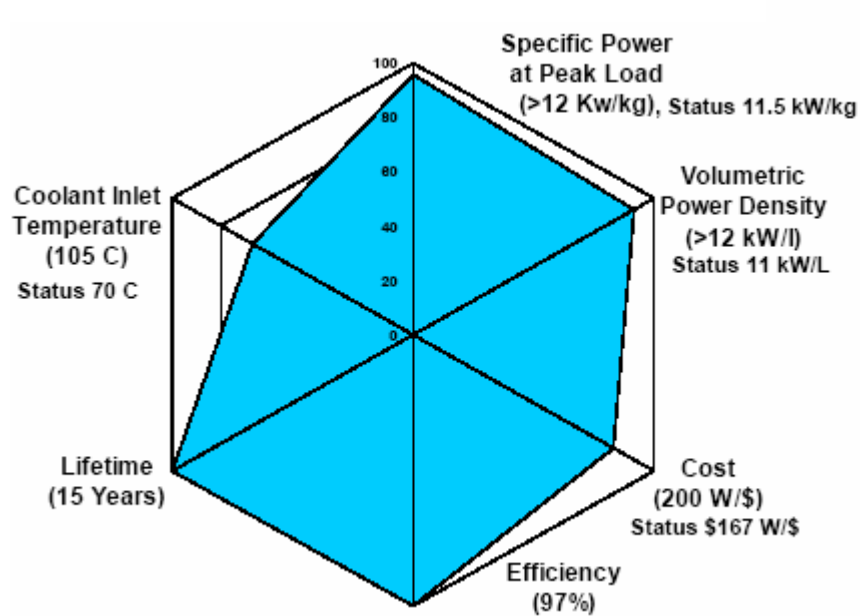
Waste Heat Recovery



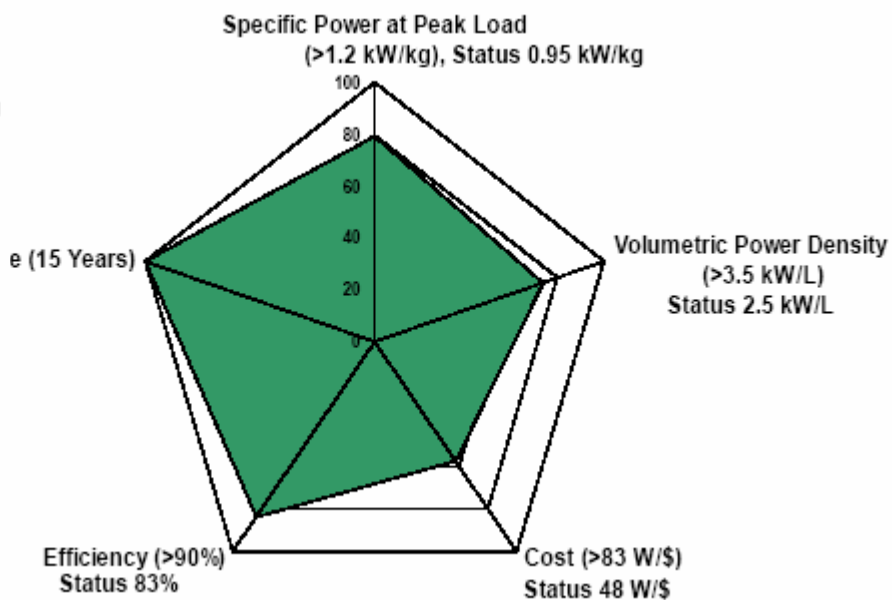
Electro-Thermal Energy Generation

More Electric Car

Technology Gaps



Power Electronics



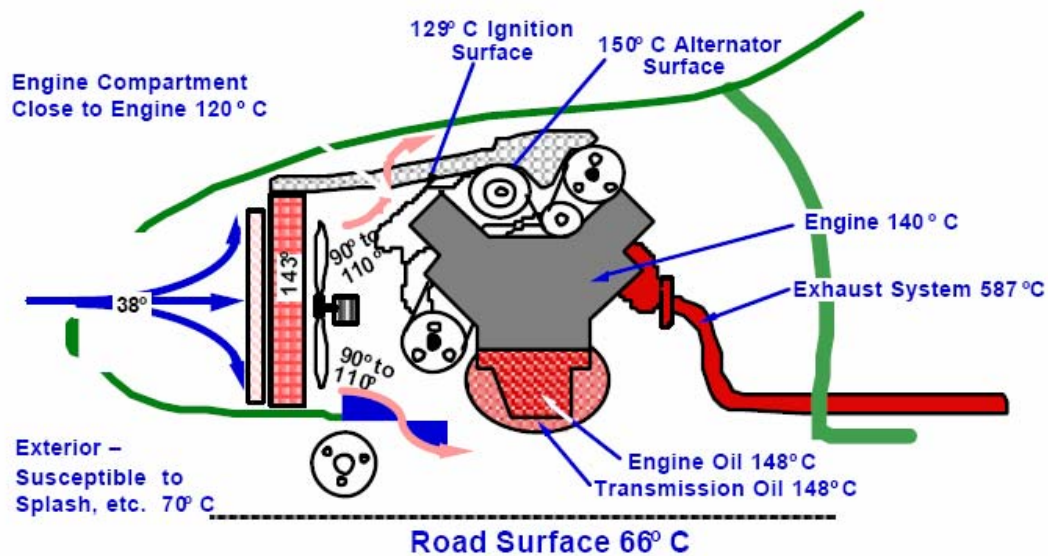
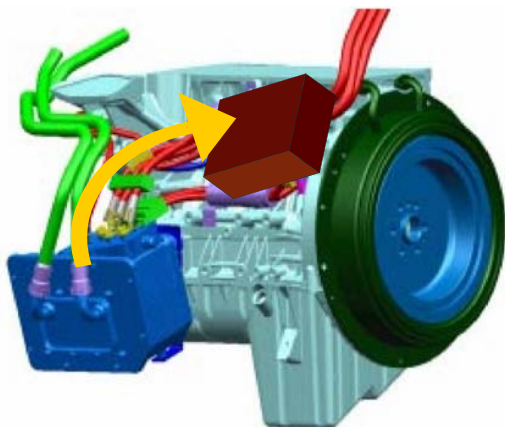
Propulsion System

More Electric Car

Power Electronics Mounted to ICE
105°C

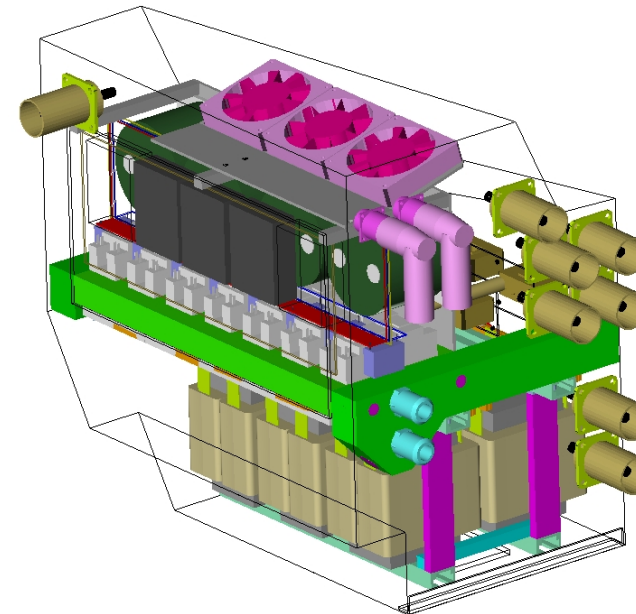
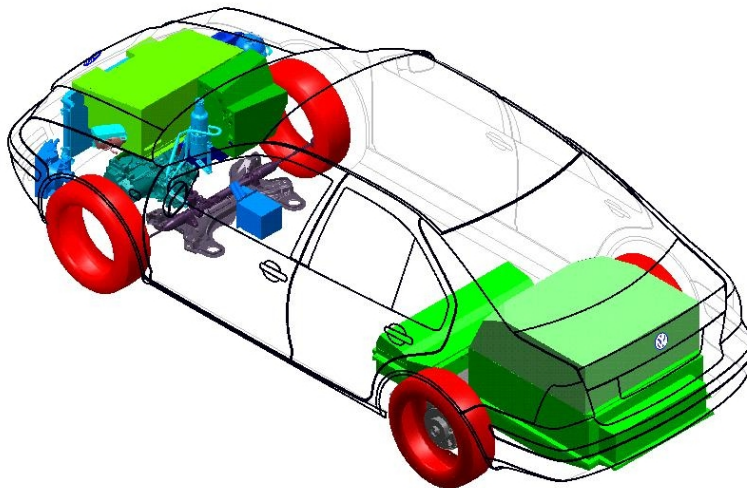
Increasing Ambient/Junction Temperature and Simultaneously Increasing Reliability Requirements

Packaging Technology with Matched CTEs



All-Electric Fuel-Cell Powered Car

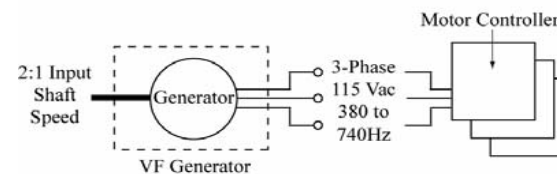
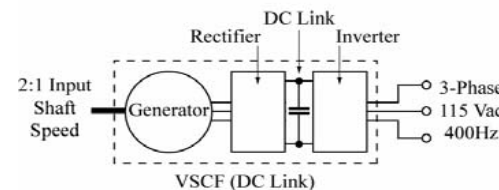
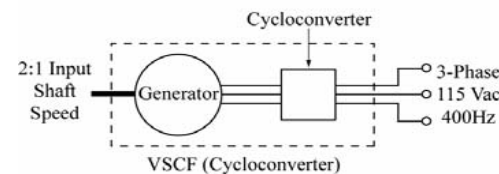
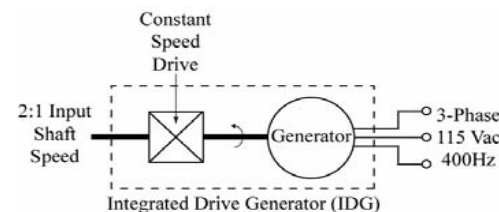
Voltage DC Link IGBT Converter
Super-Cap in Parallel to Fuel Cell
400V_{pc} (250V)
40kW_{pc} (60kW)
48kHz Interleaved Switching



More Electric Aircraft

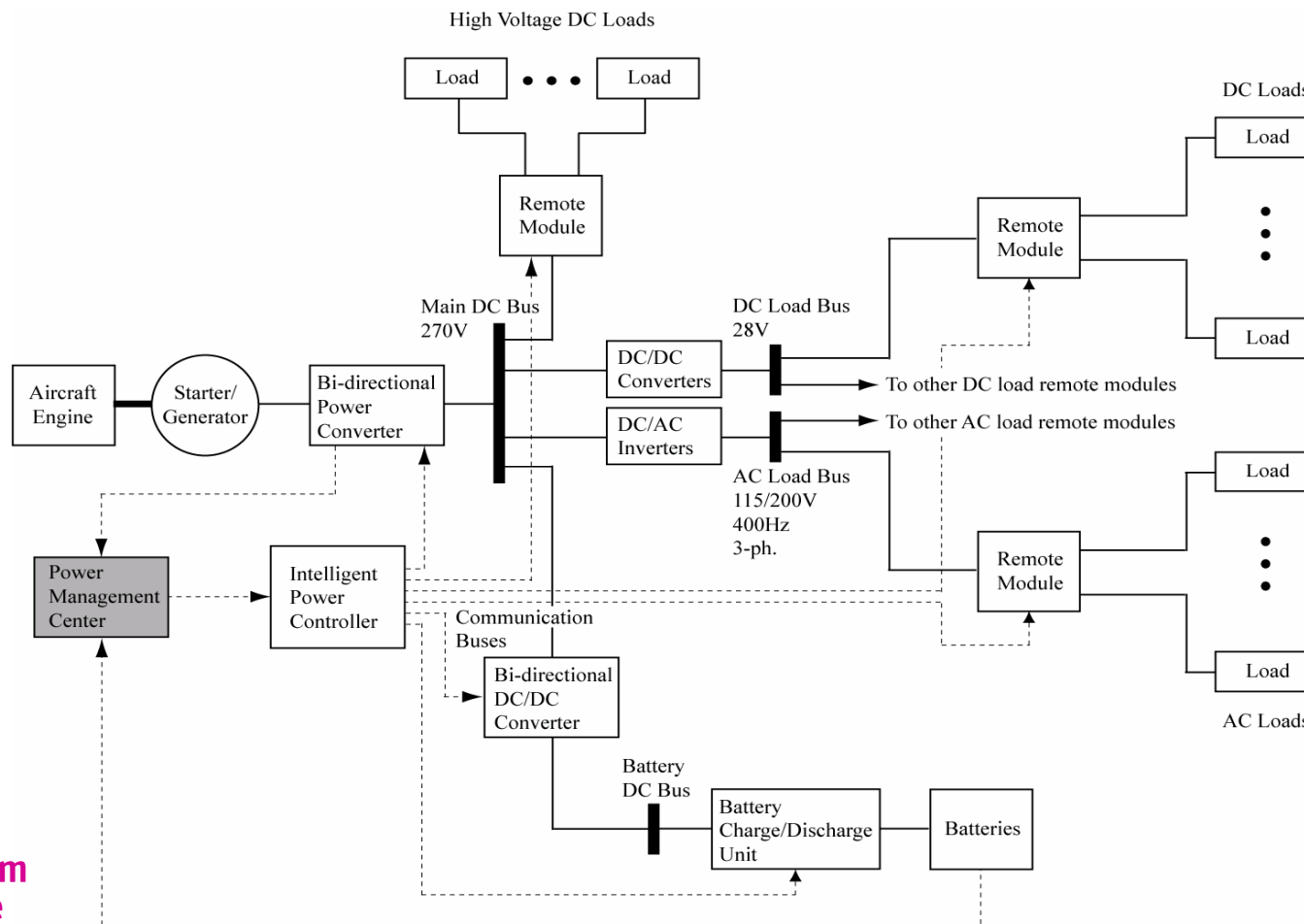
Air Traffic Growth 4.7%/a

Variable Frequency Power Generation
 270V_{DC} Power Distribution
 Replacement of Hydraulic by Electric System

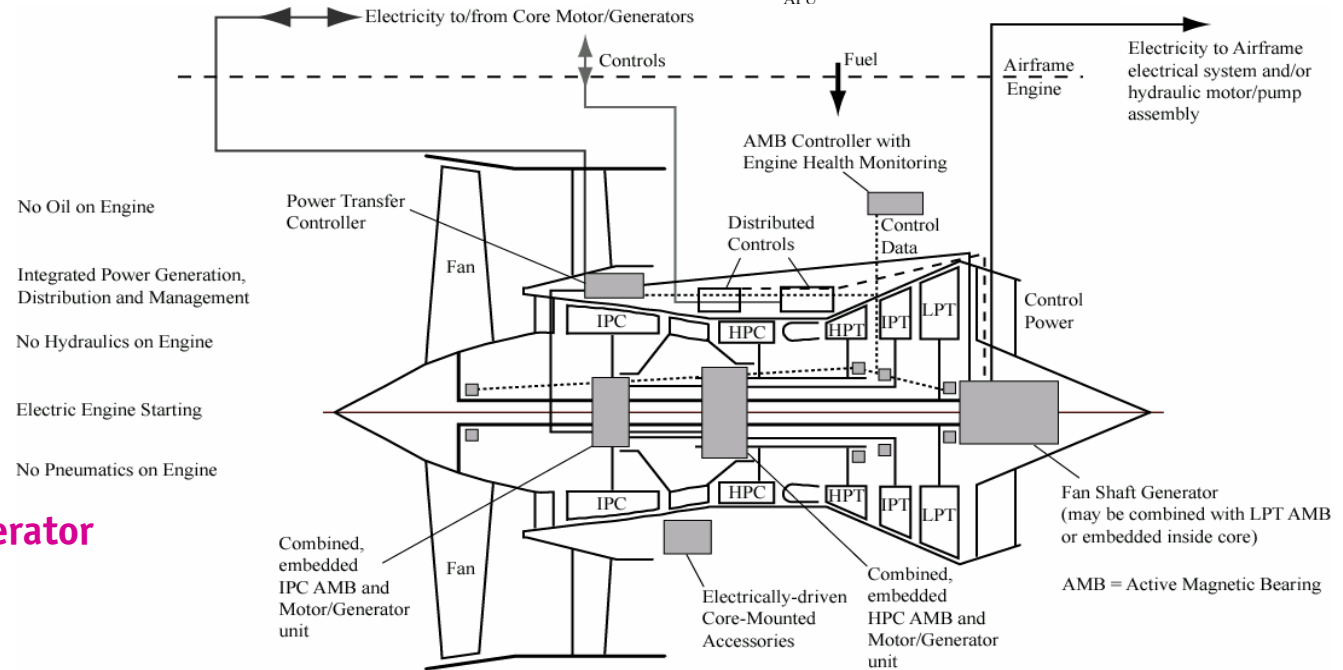
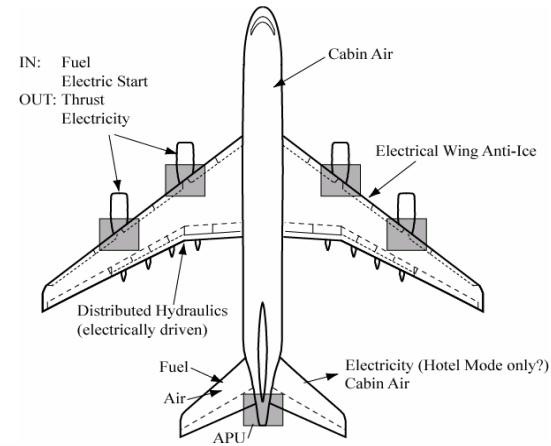


More Electric Aircraft

Power System Architecture



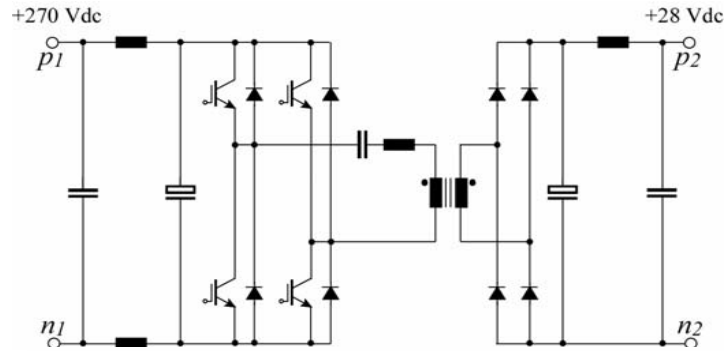
More Electric Aircraft



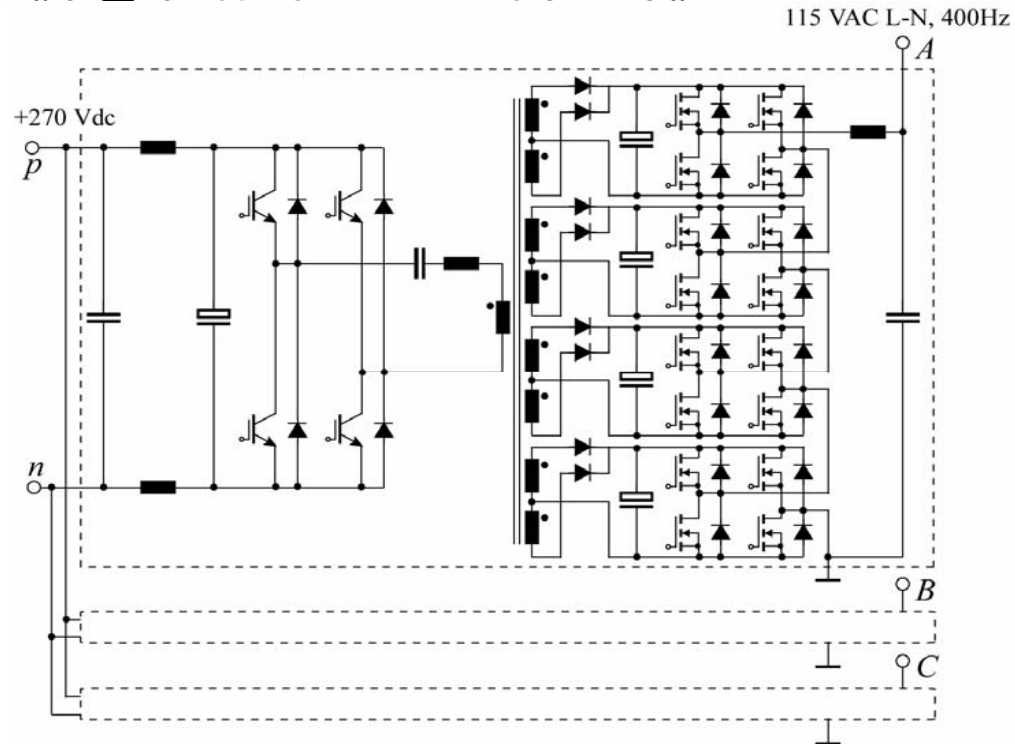
Starter / Generator System

More Electric Aircraft

DC/DC Converter



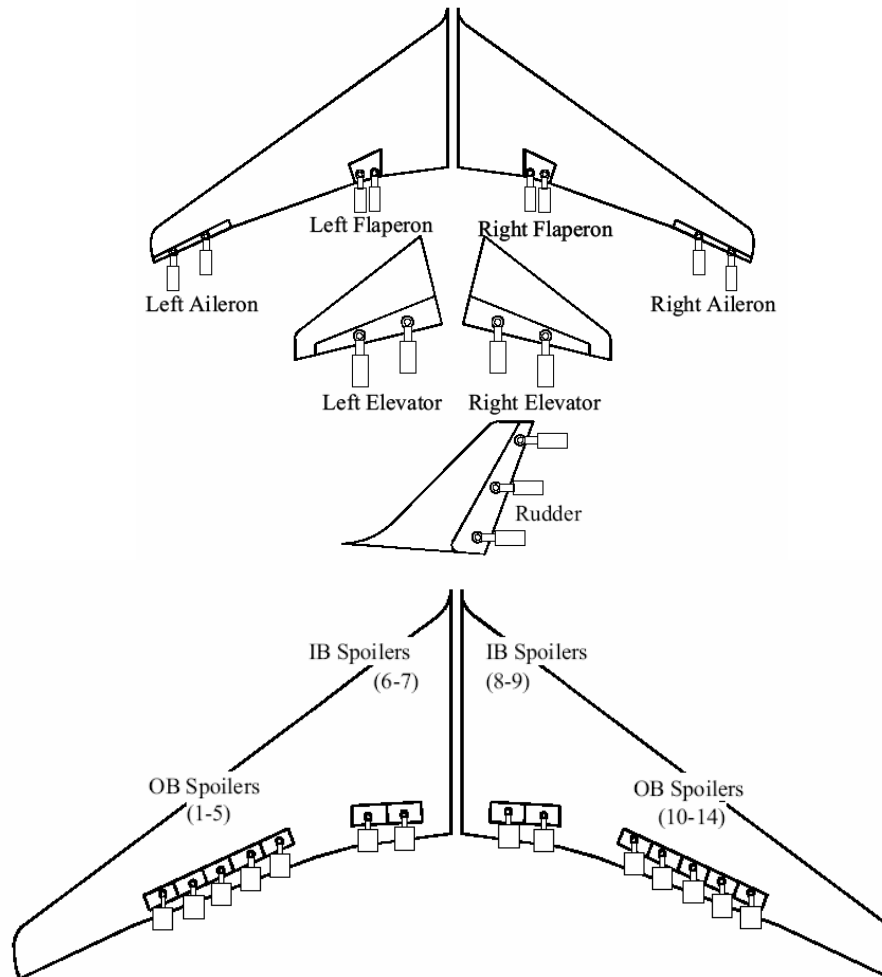
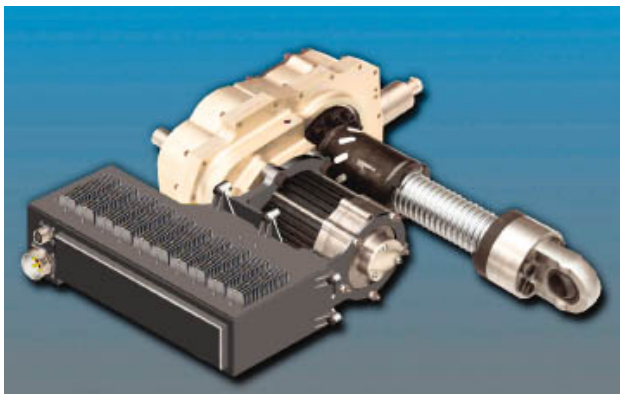
DC/AC Converter Multi-Cell Concept



More Electric Aircraft

Flight Control Surface Actuation

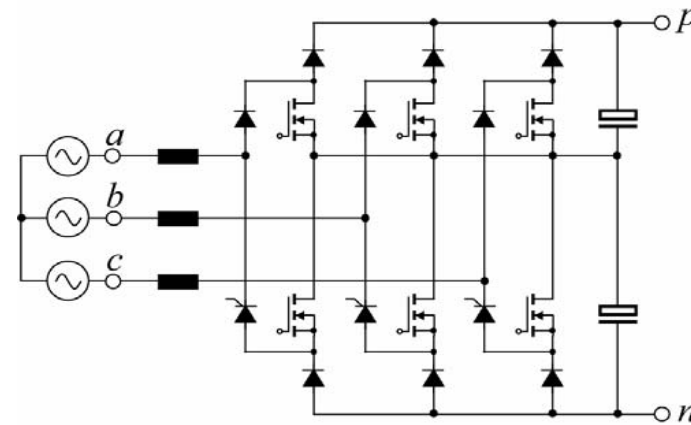
EHA Electro-Hydrostatic Actuator
EMA Electro-Mechanical Actuator



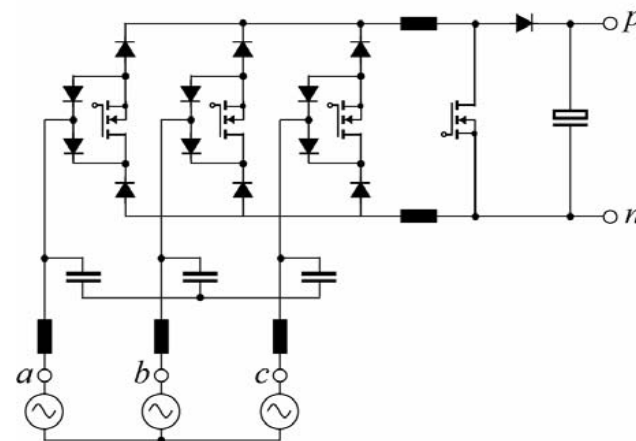
More Electric Aircraft

Three-Phase AC/DC Power Conversion with Low Effects on the Aircraft Mains

Unidirectional Three-Level Boost Converter



Unidirectional Buck+Boost Converter



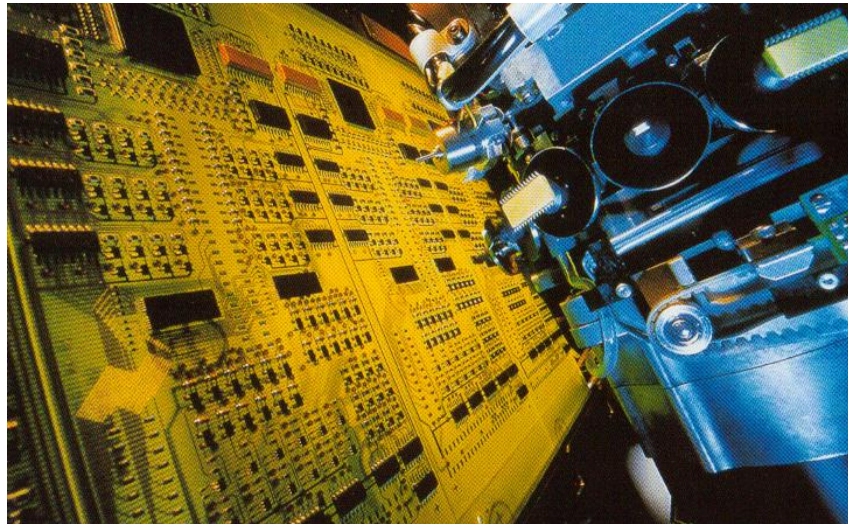
Renewable Energy



Missing Large
Scale Energy
Storage Technology

Drive Systems

**60% of Electric Energy Utilized in Germany
consumed by Drives**



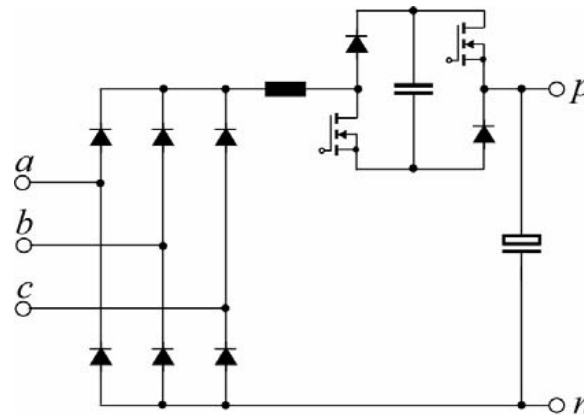
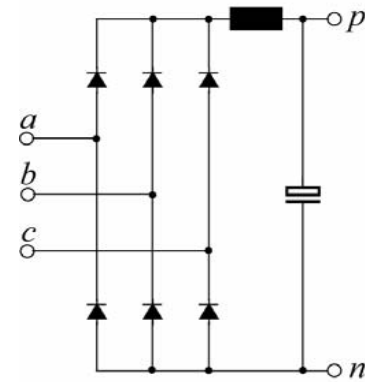
**5% Employing Electronic Speed Control
35% Possible Share / 40% Energy Saving Potential (16TWh)**

**400TWh Drives Energy Consumption in the EU
60% Energy Saving Potential**

Drive Systems

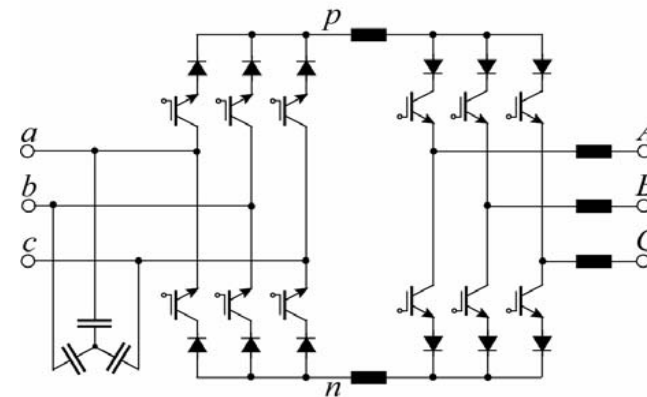
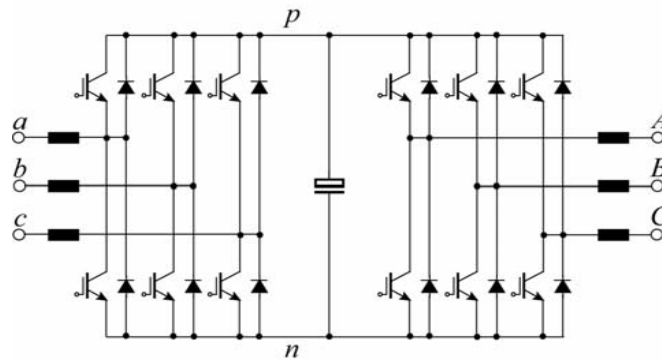
Electronic Inductor Unidirectional Utility Interface

Reduction of Effects on the Mains
 $\eta = 99\%$
 $10\text{kW}/\text{dm}^3$

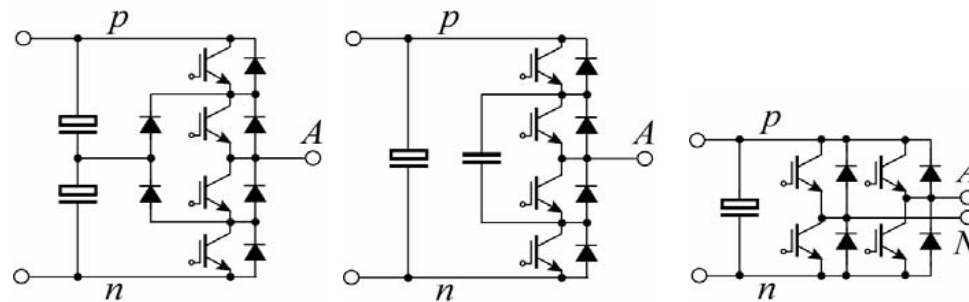


Drive Systems

Bidirectional Utility Interface

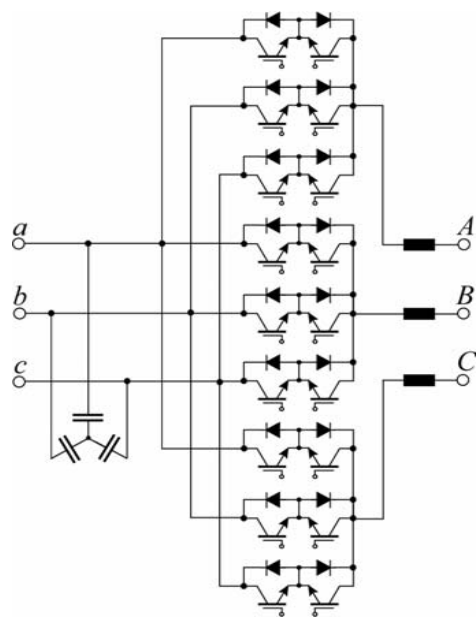


Multi-Level Converter Topologies

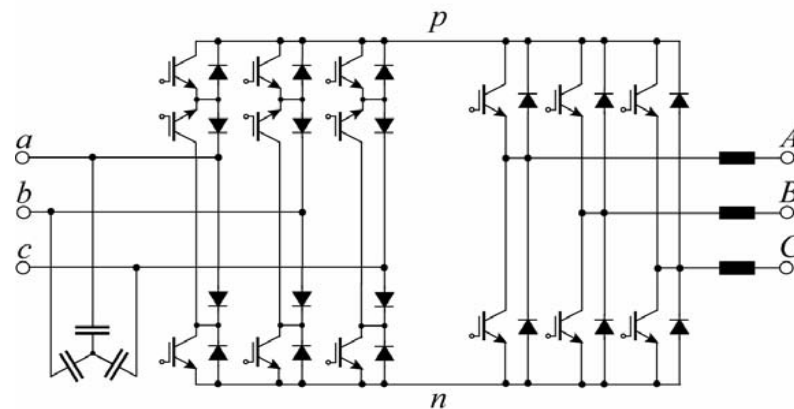
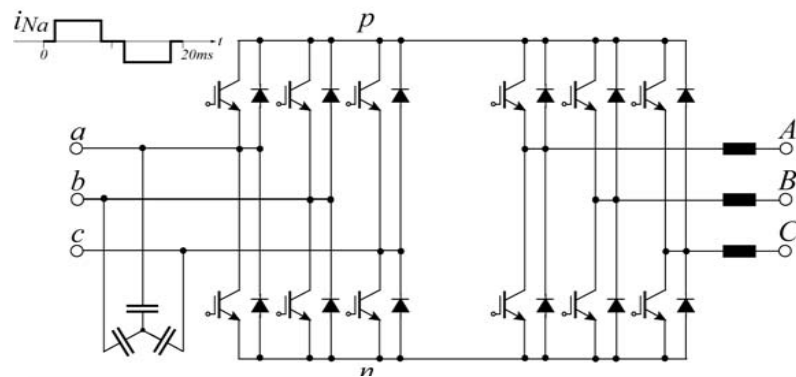


Drive Systems

Matrix Converter



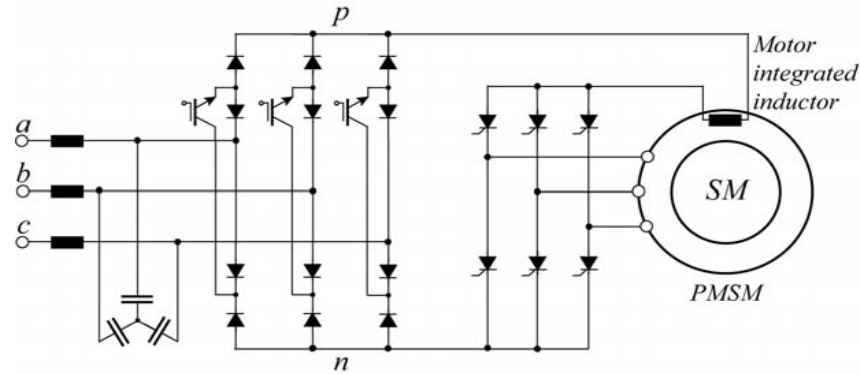
Conventional



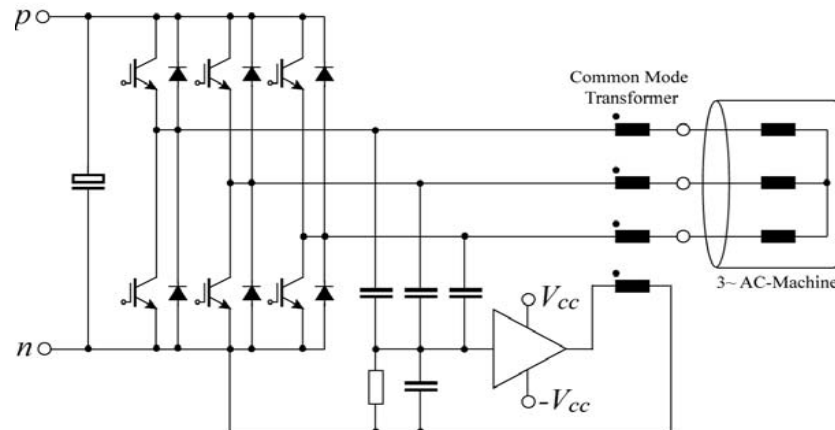
Sparse Matrix Converter

Drive Systems

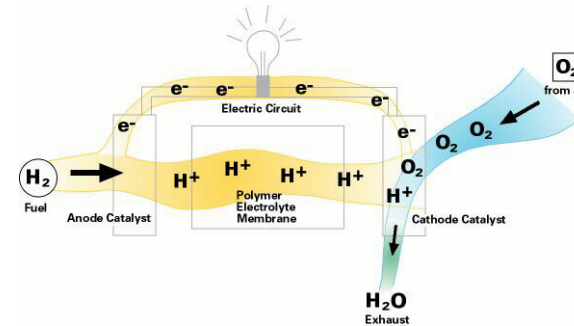
Quasi-Matrix Converter



Active Common-Mode EMI Filtering

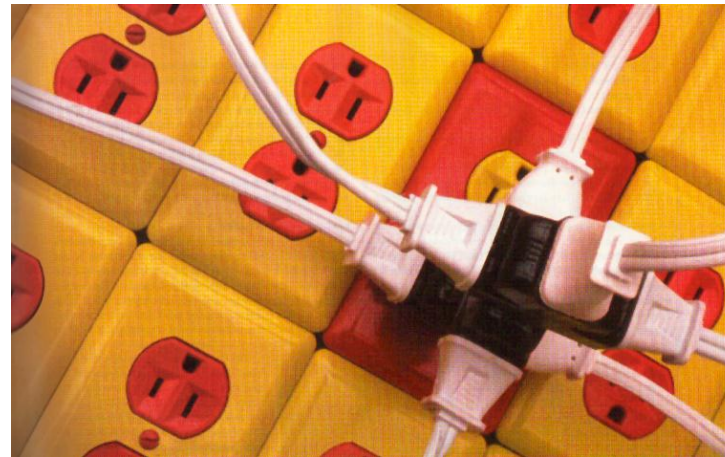


Distributed Generation and Storage



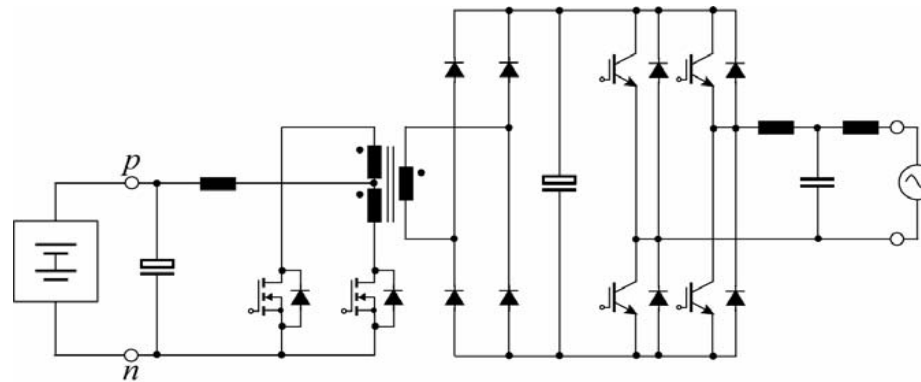
Fuel Cell

Co-Generation
65% Combined Efficiency
Custom Power / UPS

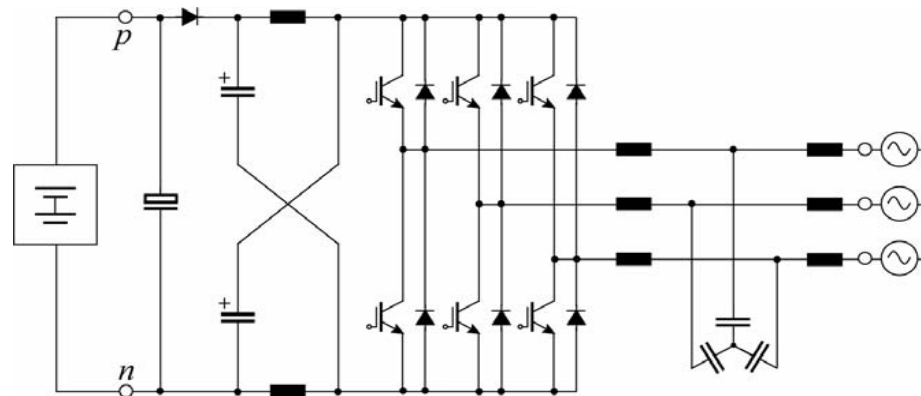


Fuel Cell Utility Interface

Single-Phase
Isolated

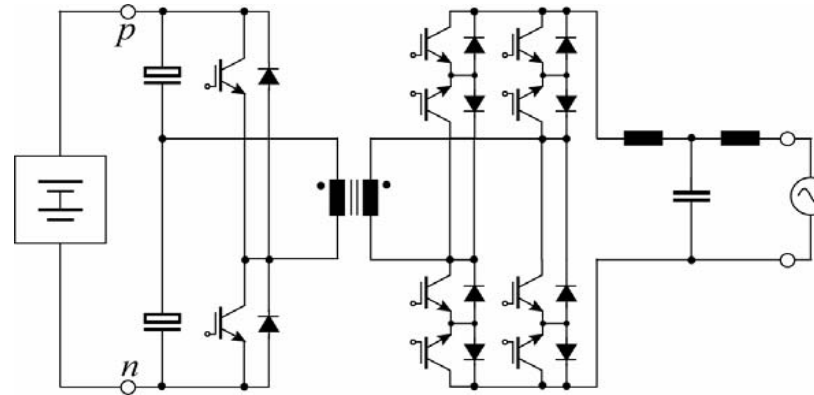


Three-Phase
Z-Source
Inverter

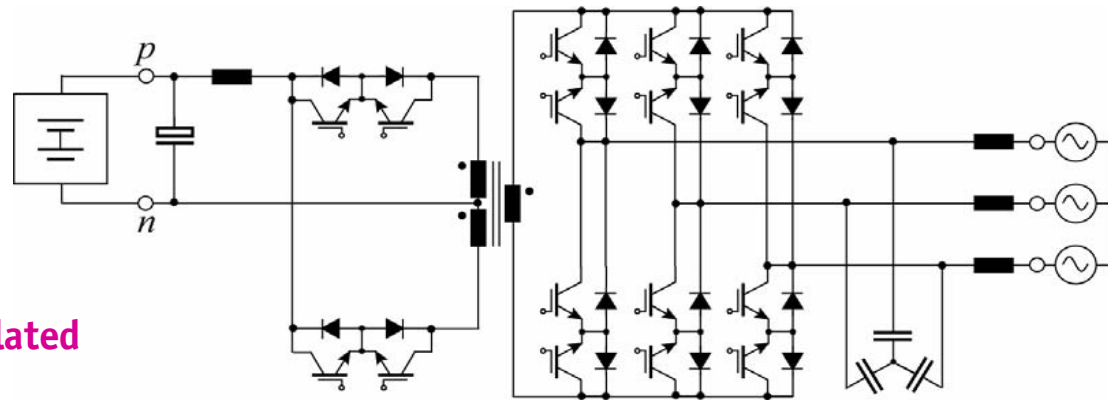


Fuel Cell Utility Interface

Single-Phase
High-Frequency Isolated
DC/AC Matrix Converter



Three-Phase
High-Frequency Isolated
Matrix Converter



Power System with Fully Integrated Network Control

Self-Healing

Wide-Area
Monitoring

Power Flow
Controlled
Instantaneously
using Power
Electronic Systems

Premium Power
and DC Service

Plug & Play of
Distributed
Resources



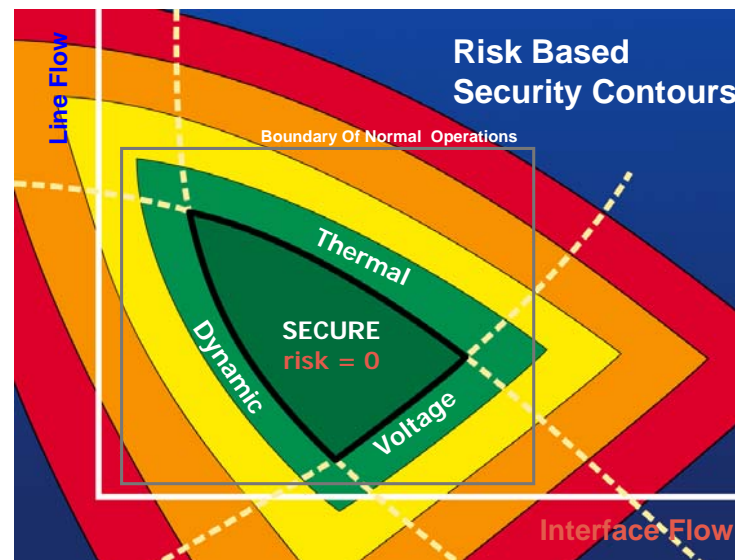
Visualize Critical Information

Displays the Limits of Power Market Activities Imposed by Constraints on the Underlying Power System

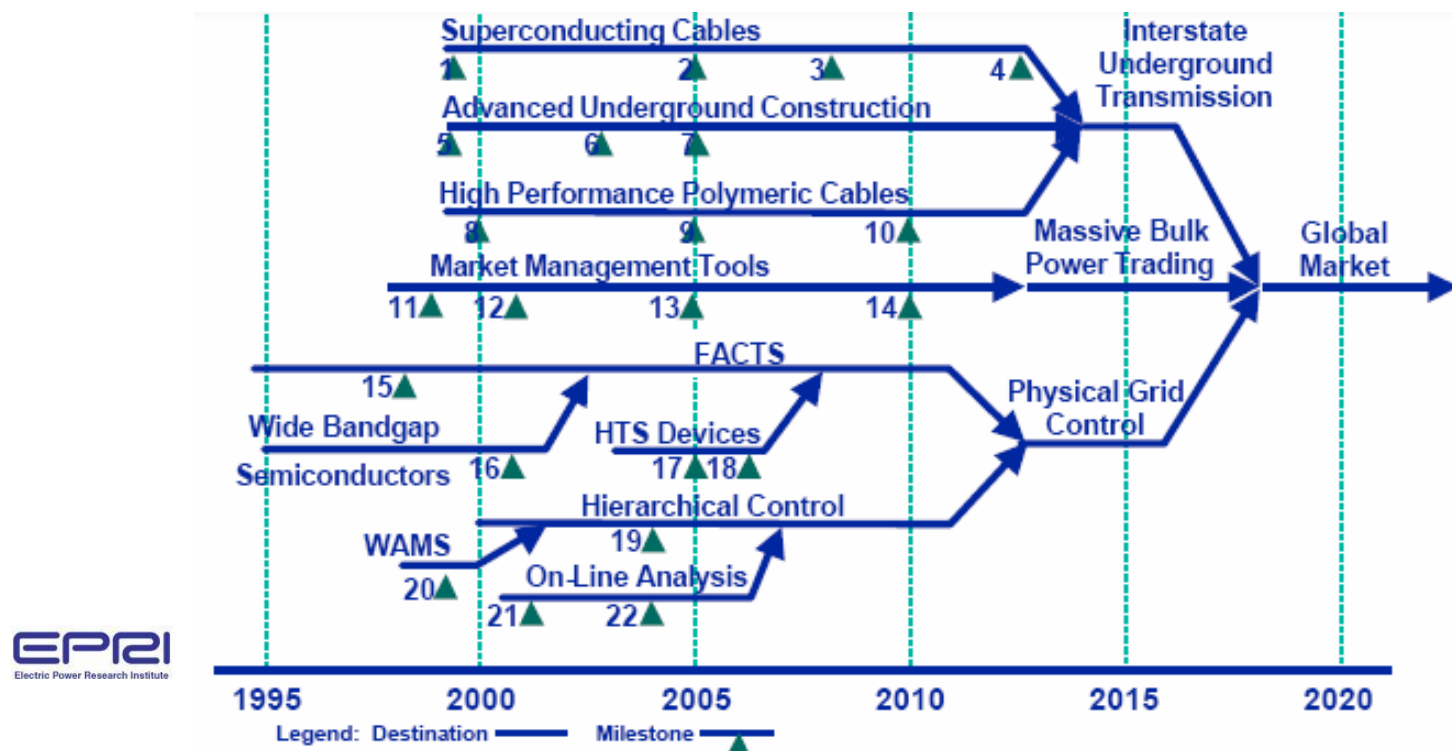
Locates System Bottlenecks

Suggests Combinations of Net Power Import and Export

Promotes Integration of System Reliability and Market Efficiency



Roadmap Tree for Power Delivery Technologies

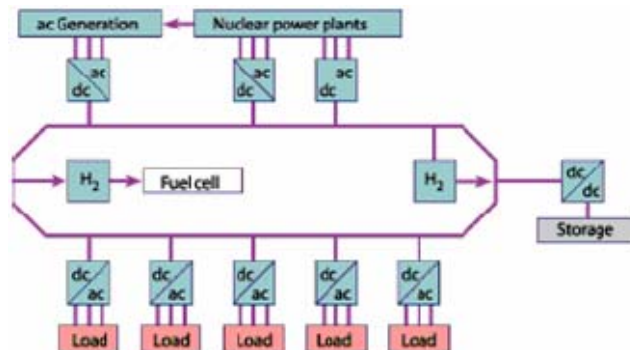


Future U.S. Energy Distribution

Super Grid Concept EPRI

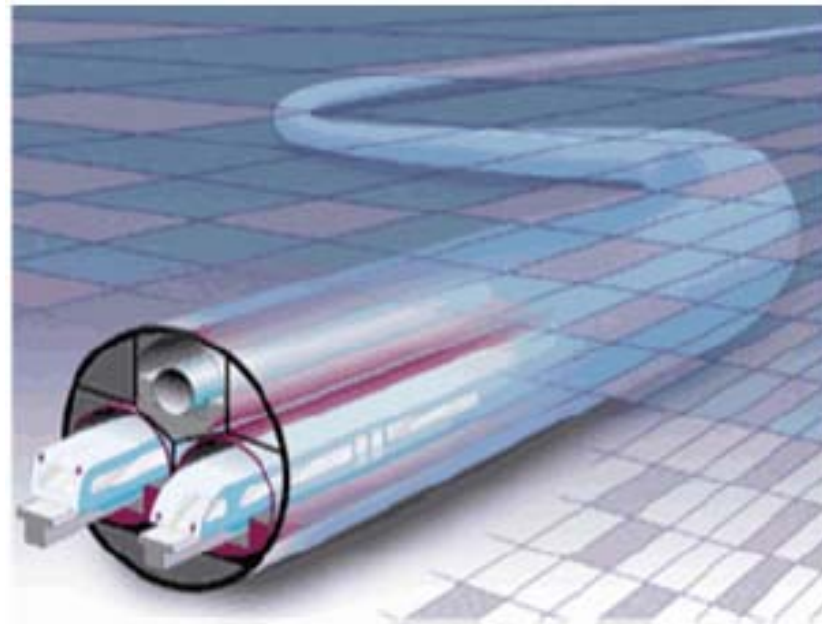
3,000,000 MW Worldwide
Electric Utility Generation

700,000 MW in the U.S.
15,000 MW/a added
6,000 MW/a replaced



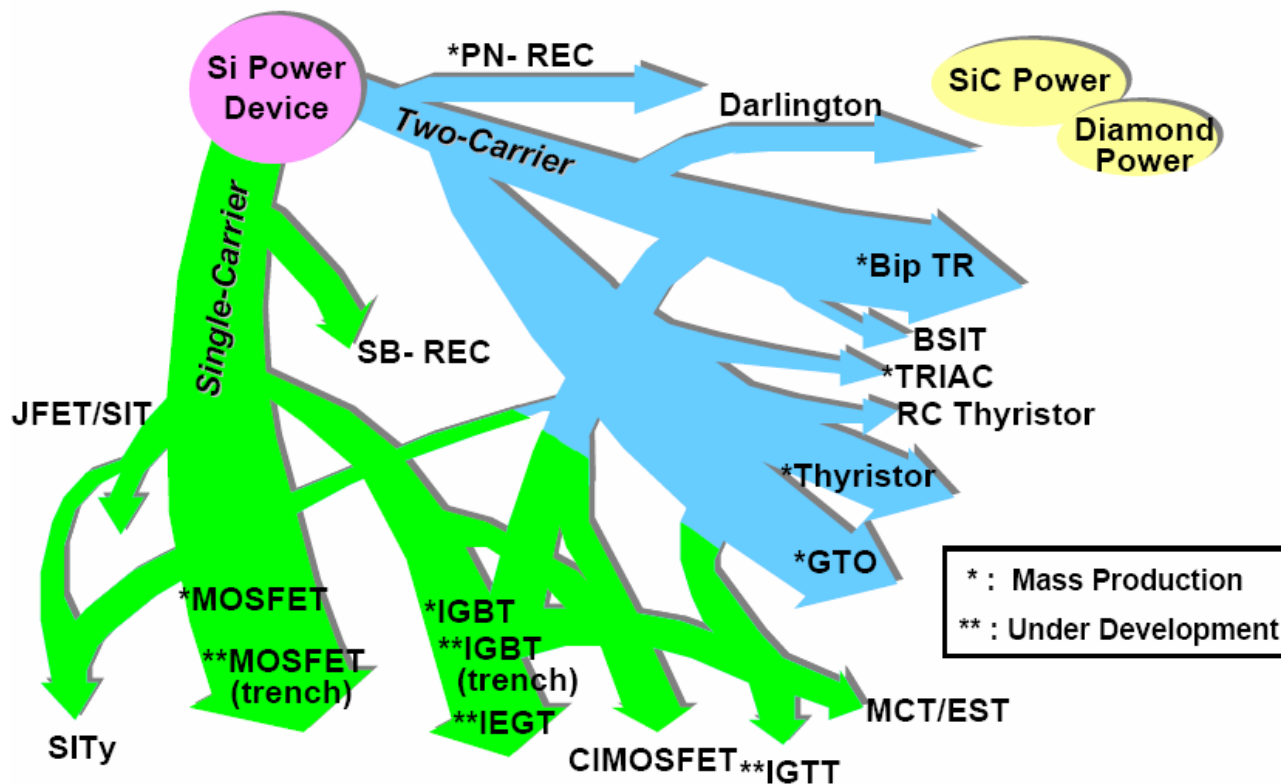
Efficient Coast-to-Coast Underground
Transport of Large Amount of Energy –
40...80GW

Simultaneous Delivery of
Electricity and Liquid Hydrogen
Combined with MAGLEV Systems



Power Semiconductor Evolution

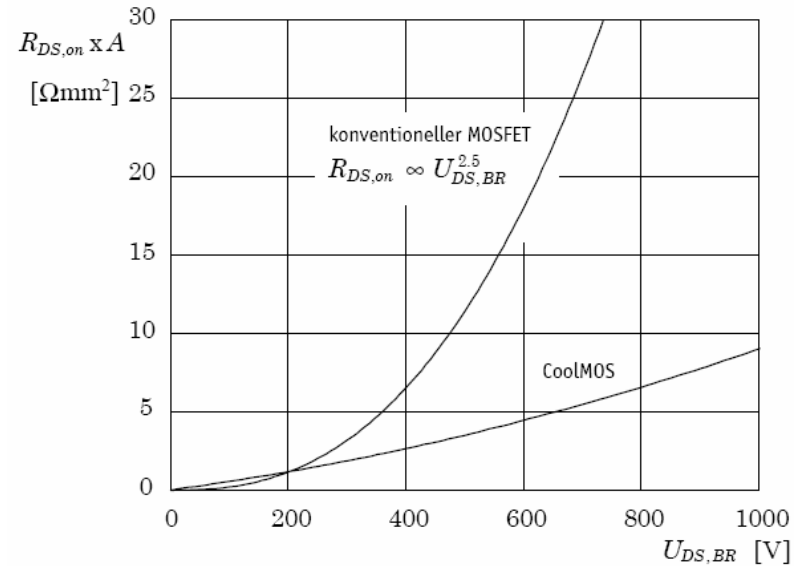
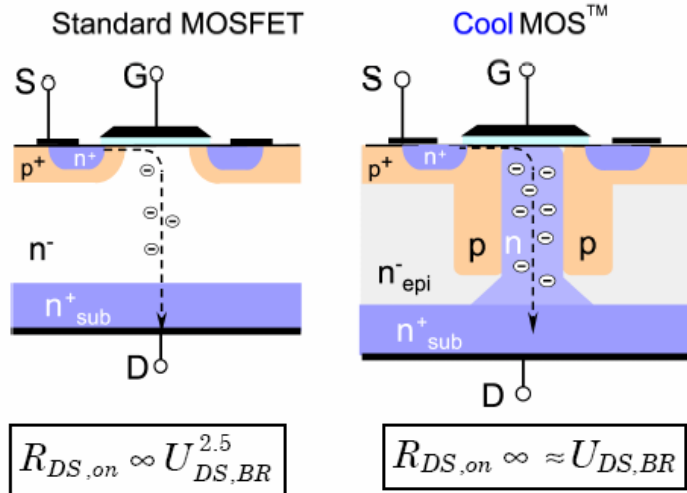
Spread of Power Device



Power MOSFET Revolution

Charge Compensation Principle
High-Doped n-Region / p-Columns

Low On-State Resistance
50V V_{DS} Depletion Threshold
Space Charge Region Extends Across Epi-Layer
High Breakdown Voltage
Capacitive Dynamic Behavior

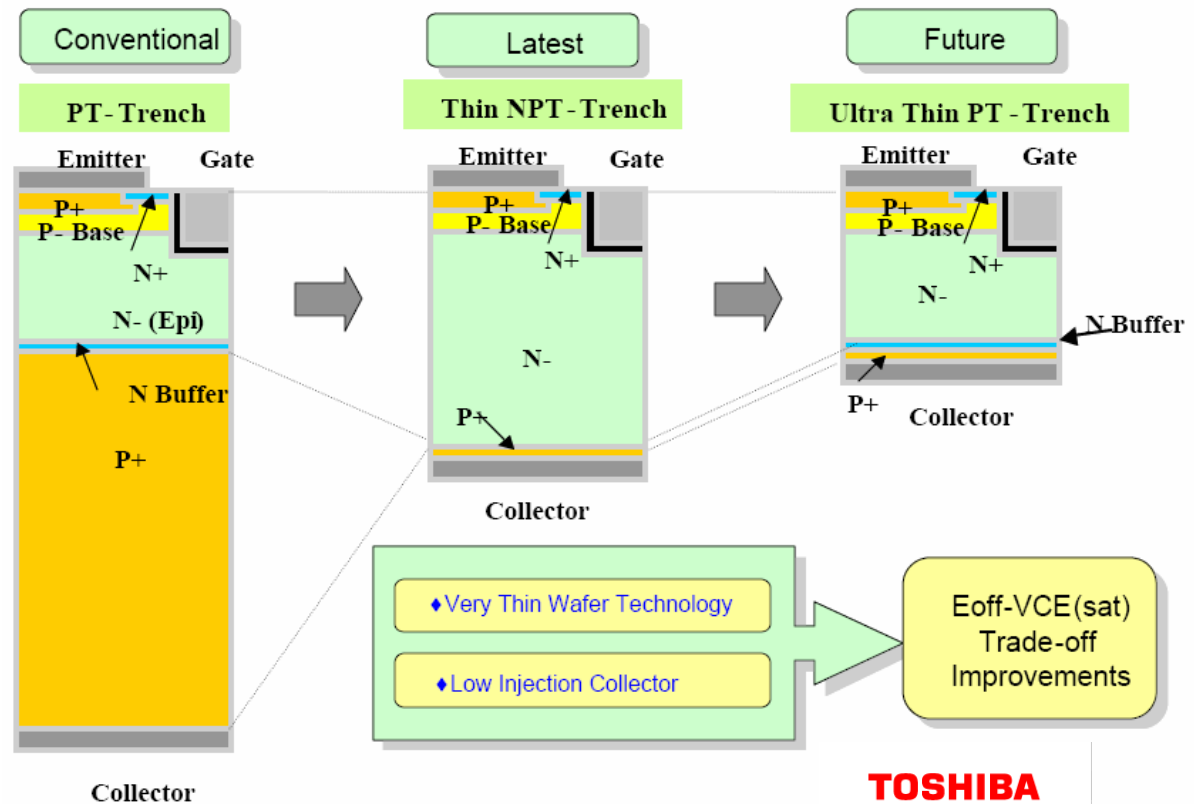


Evolution of IGBT Technology

IGBT Chip Development Trend (600V)

Trench Technology Field-Stop Concept

power electronics in motion
eupec
 600V IGBT³
 First IGBT Rated for
 $T_j = 175^\circ\text{C}$

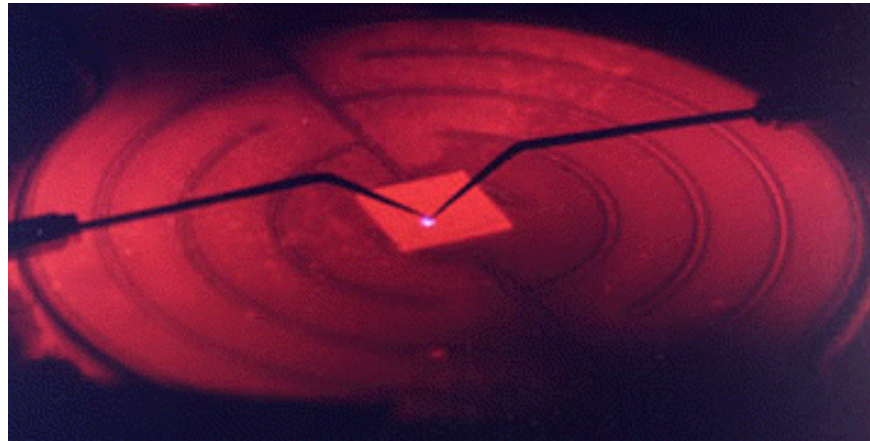


SiC Power Semiconductor Devices

Advantages SiC / Si

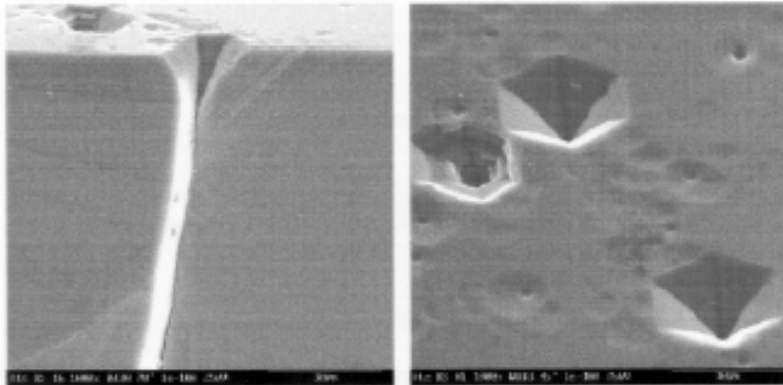
Bandgap (eV@300K)	2.9 / 1.1
Max. Operating Temp. (K)	>900 / 425
Breakdown Voltage (10^6 V/cm)	4 / 0.3
Thermal Conductivity (W/cm.K)	5 / 1.5

SiC Rectifier Diode
Probe-Tested at
600°C



SiC Power Semiconductor Devices

Challenges



Cross section

Top view

**SiC Wafer Defects –
Micropipes and Screw
Dislocation**

<5/cm²

Low Processing Yield

**Defect Density
Required for
1200V/100A Devices
<3/cm²**

**2002 SiC Wafer
Production Capacity
94% US Share**

**High Temperature
Packaging Techniques**

**Compatible Gate Drives
and Passives**

SiC Power Semiconductor Devices



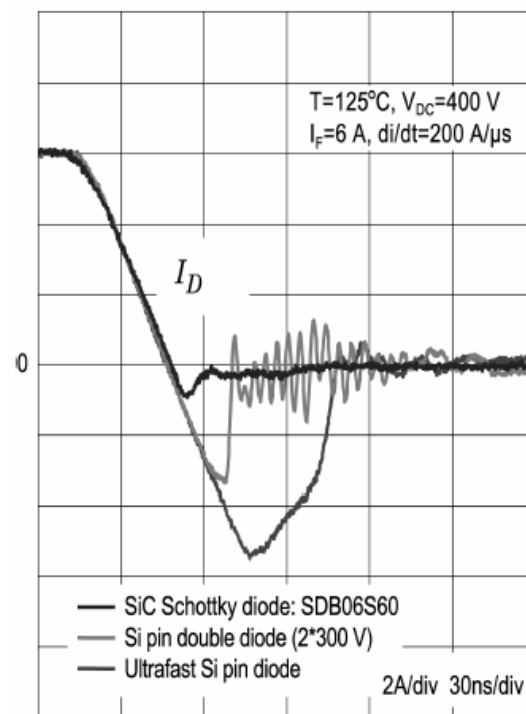
SiC Schottky Diodes

600V 35A
1200V 25A
1700V 20A

SiC J-FETs

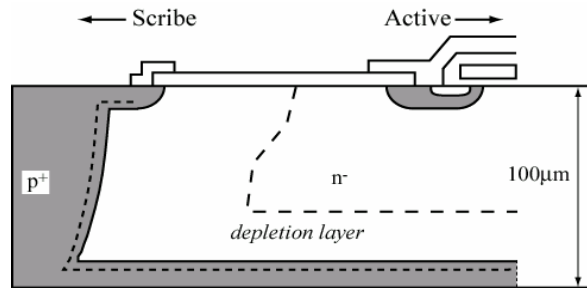
1200V 5A / 10A
1800V 3A / 8A

600V SiC Schottky Diode
Positive Temp. Coefficient of V_F
No Reverse Recovery Current

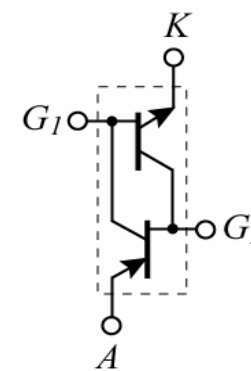
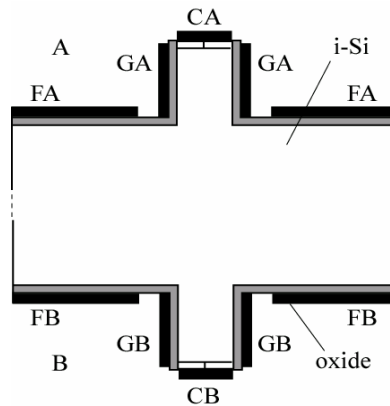


Si Power Semiconductor Development

Reverse Blocking IGBT



Monolithic Bidirectional Switch

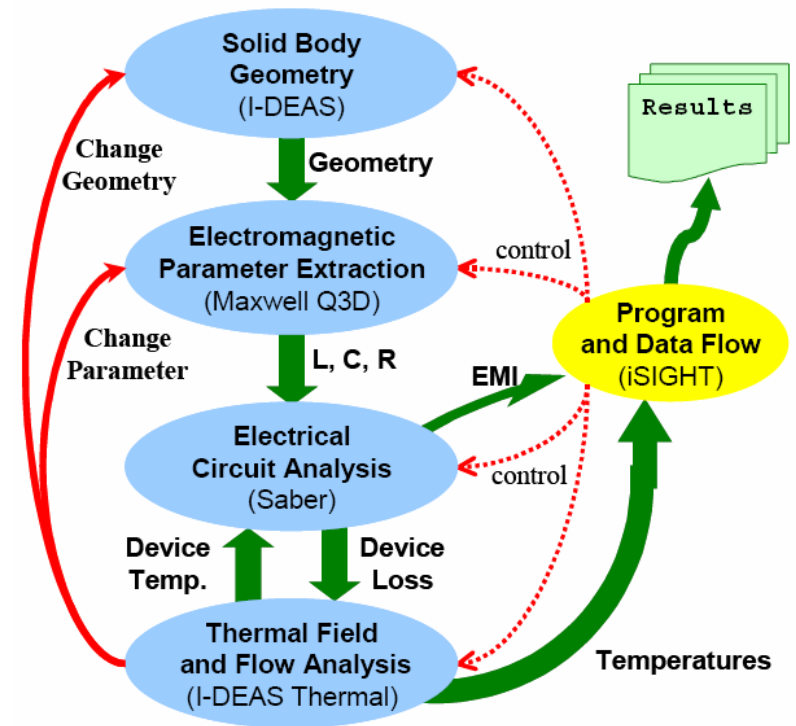
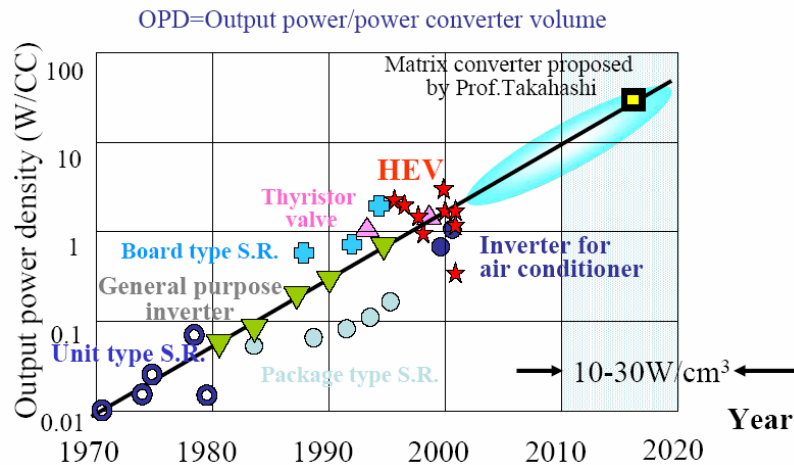


Dual-Gate IGBT
ABB

Future Developments

System Design Integrated Multidisciplinary Modeling and Analysis
 Circuit/Control/Thermal
 Electromagnetic/
 Mechanical CAD

Power Density $2\text{kW}/\text{dm}^3 \rightarrow 50\text{kW}/\text{dm}^3$

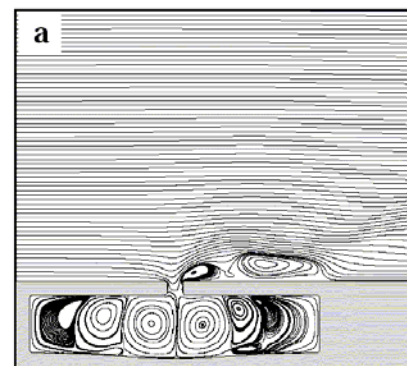
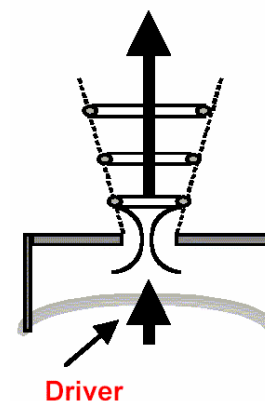
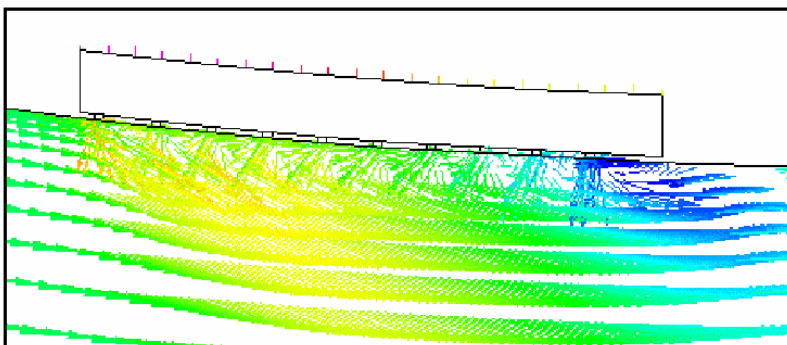


Advanced Packaging and Active Cooling Schemes

Power Loss Density 100...1000W/cm²
High Ambient Temperature Applications
High Junction Temperature WBG Devices
Advanced Packaging

Forced Liquid Cooling
Spray Cooling, Shower Power,
Micro Channel Heat Sink

Note: Improved Forced Air Cooling by
Synthetic Jets / Acoustic Streaming



Power Electronics Research Centers

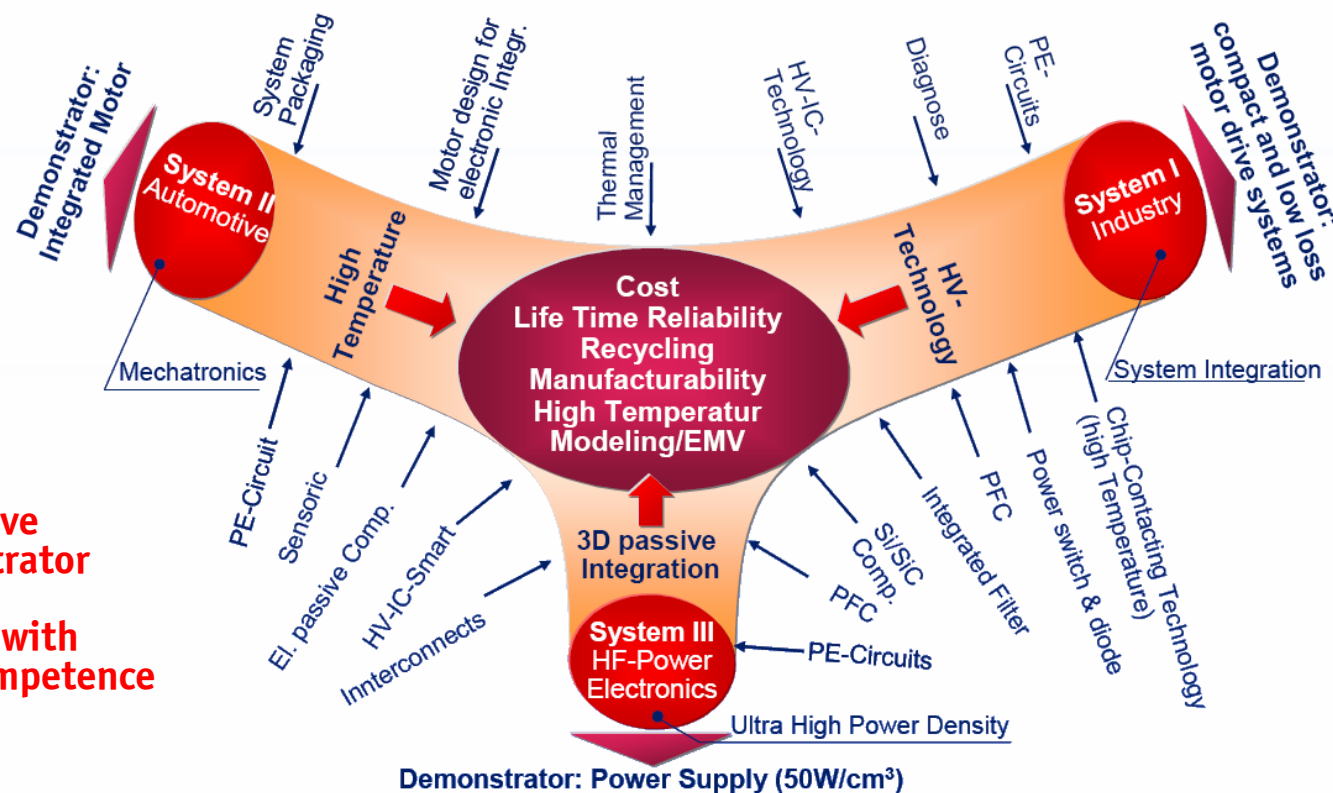


European Engineering Center for Power Electronics

Founded in 2003

14 Industry Members

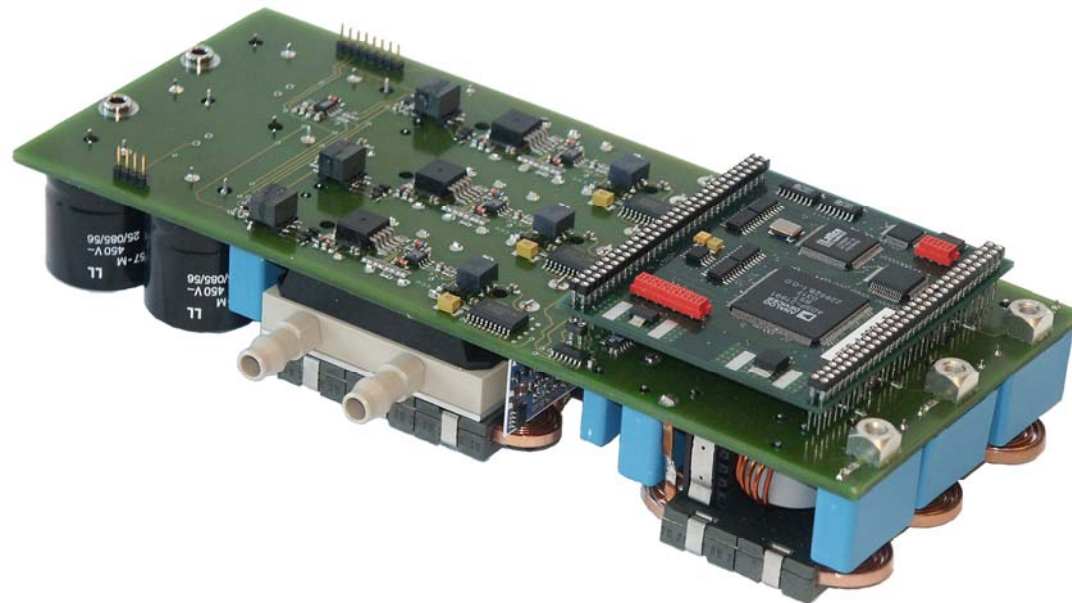
Pre-Competitive ECPE Demonstrator Program in Collaboration with University Competence Centers



Three-Phase 1-U Power Supply Module

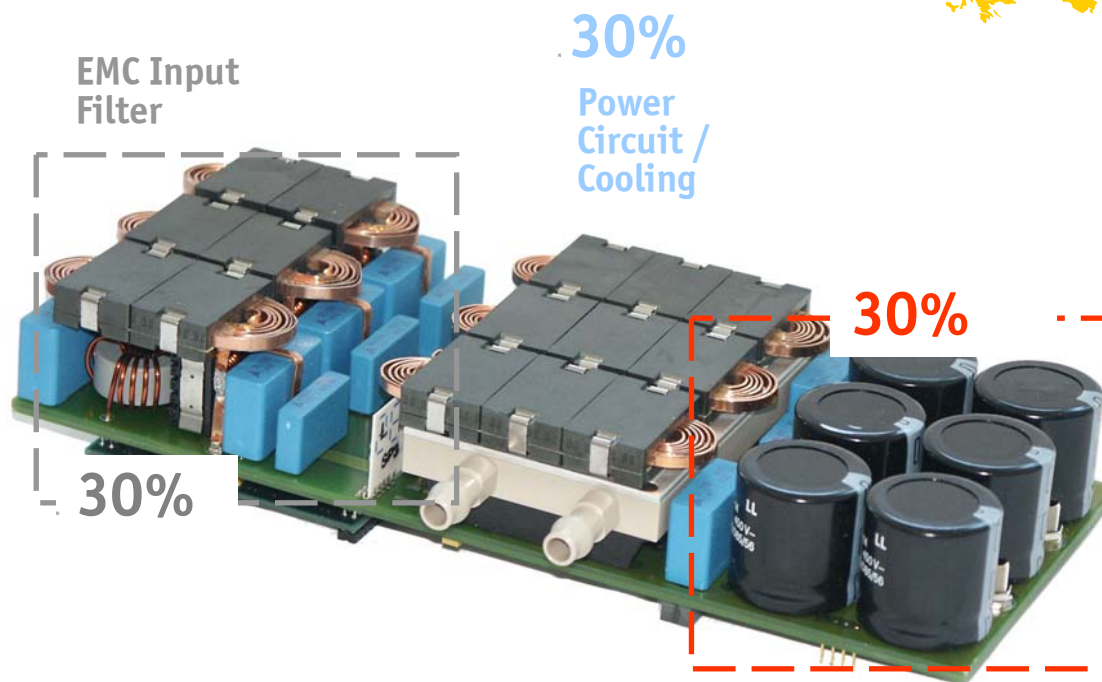


Specifications **10 kW**
3- Φ 480V_{AC}
800 V_{DC}
500 kHz
10 kW/dm³



COOLMOS / SiC-Diodes
Micro-Channel Heat Sink
High-Speed DSP-Control
Flat Magnetics
HBW & CMR Current Sensing

Partitioning of the Converter Volume



Main Share of Passive Components

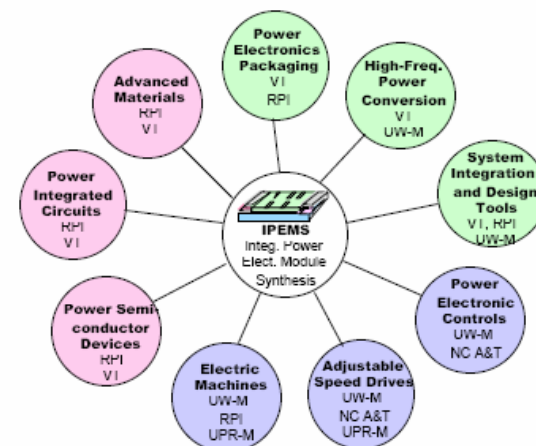
Increase of Switching Frequency
Active EMI Filtering

Electrolytic Capacitors

Power Electronics Research Centers



- Center for Power Electronic Systems, USA
- Consortium of 5 Universities 70 Industrial Partners
- IPEM Approach, Research on Fundamental Knowledge/Enabling Technology/Engineered Systems



- PERC, Power Electronics Research Center, Japan, coordinated by the National Institute of Advanced Science and Technology
- Industry-Academia-Government Collaboration Research
- Research focused on Ultra-Low-Loss Power Device Technology (SiC, GaN)

Future



**Power Electronics is the Key
and Enabling Technology for all Kinds
of Electric Energy Utilization !**